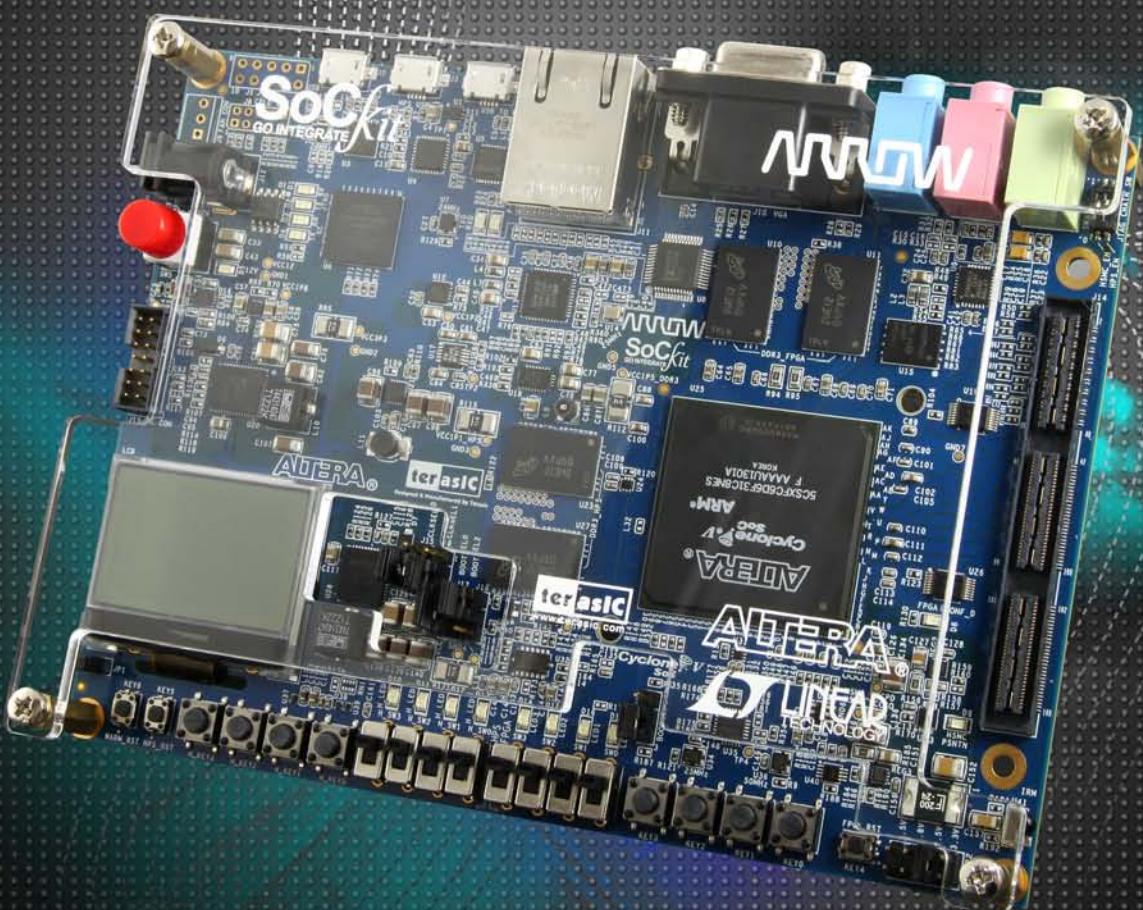


SoCKit

USER MANUAL





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Chapter 1

SoCKit Development Kit

The SoCKit Development Kit presents a robust hardware design platform built around the Altera System-on-Chip (SoC) FPGA, which combines the latest dual-core Cortex-A9 embedded cores with industry-leading programmable logic for ultimate design flexibility. Users can now leverage the power of tremendous re-configurability paired with a high-performance, low-power processor system. Altera's SoC integrates an ARM-based hard processor system (HPS) consisting of processor, peripherals and memory interfaces tied seamlessly with the FPGA fabric using a high-bandwidth interconnect backbone. The SoCKit development board includes hardware such as high-speed DDR3 memory, video and audio capabilities, Ethernet networking, and much more. In addition, an on-board HSMC connector with high-speed transceivers allows for an even greater array of hardware setups. By leveraging all of these capabilities, the SoCKit is the perfect solution for showcasing, evaluating, and prototyping the true potential of the Altera SoC.

The SoCKit Development Kit contains all components needed to use the board in conjunction with a computer that runs the Microsoft Windows XP or later.

1.1 Package Contents

Figure 1-1 shows a photograph of the SoCKit package.



Figure 1-1 The SoCKit package contents



The SoCKit package includes:

- The SoCKit development board
- USB Cable for FPGA programming and control
- Ethernet Cable
- 12V DC power adapter

1.2 SoCKit System CD

The SoCKit System CD containing the SoCKit documentation and supporting materials, including the User Manual, System Builder, reference designs and device datasheets. User can download this System CD form the link : http://sockit_support.terasic.com.

1.3 Getting Help

For discussion, support, and reference designs, please go to:



RocketBoards.org

- [Arrow SoCKit Evaluation Board](#)
- [Arrow SoCKIT Evaluation Board - How to Boot Linux](#)

Here are the addresses where you can get help if you encounter any problem:

- Terasic Technologies

Taiwan/ 9F, No.176, Sec.2, Gongdao 5th Rd, East Dist, Hsinchu City, Taiwan 300-70

Email: support@terasic.com

Tel.: +886-3-5750-880

Web: <http://sockit.terasic.com>

Chapter 2

Introduction of the SoCKit Board

This chapter presents the features and design characteristics of the board.

2.1 Layout and Components

A photograph of the board is shown in **Figure 2-1** and **Figure 2-2**. It depicts the layout of the board and indicates the location of the connectors and key components.

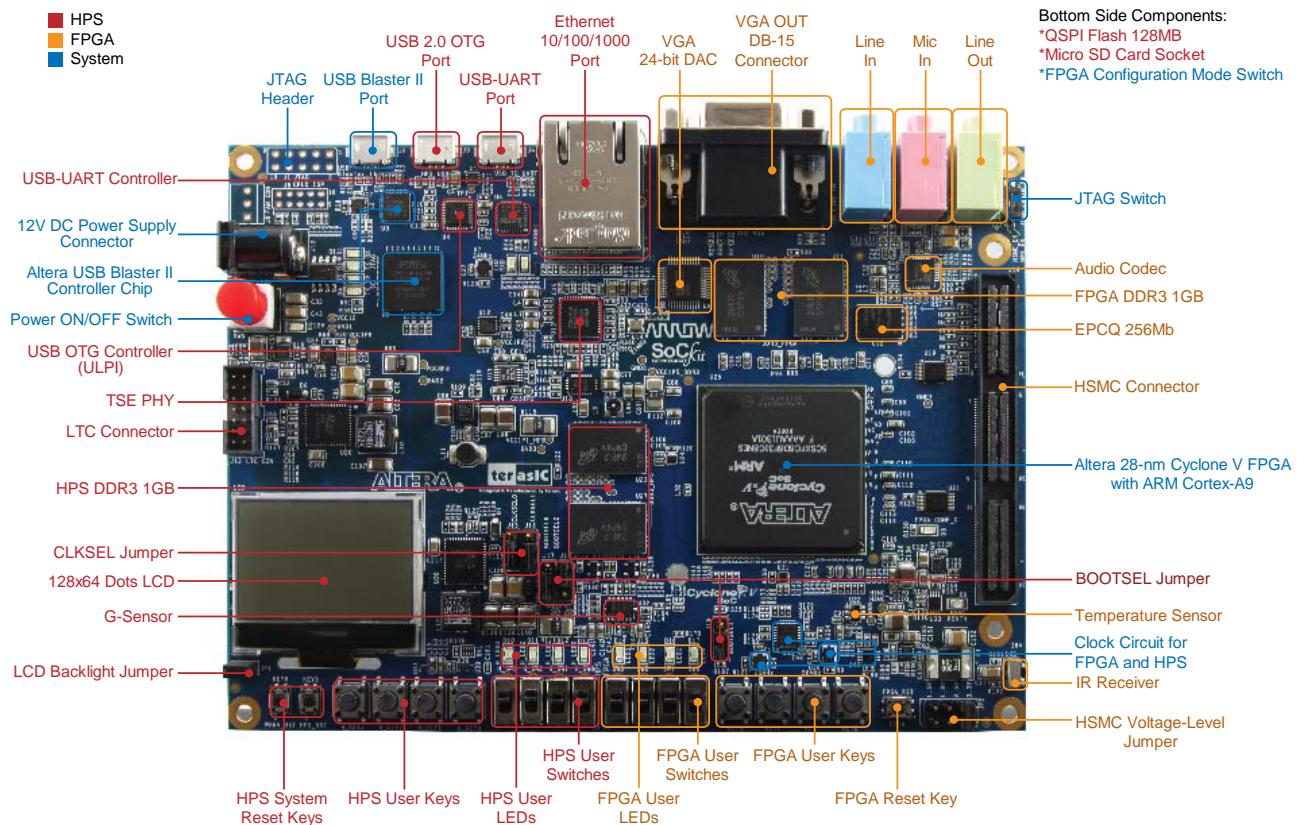


Figure 2-1 Development Board (top view)

■ HPS
■ FPGA
■ System

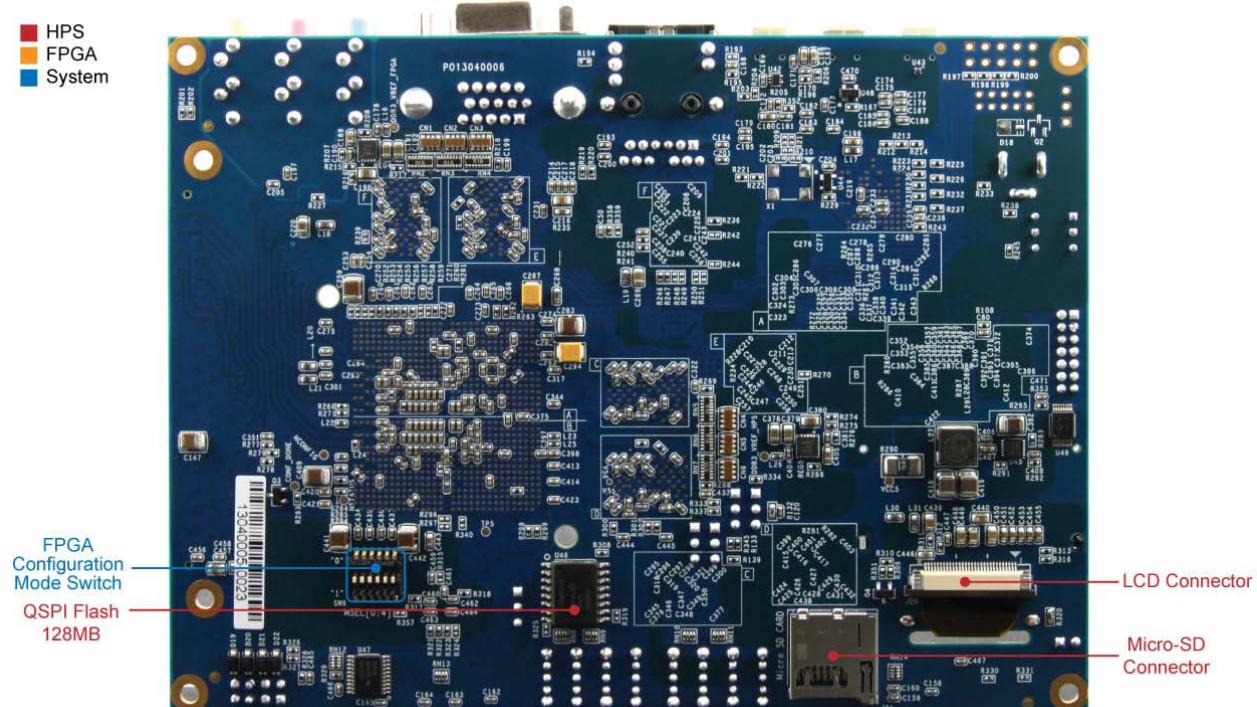


Figure 2-2 Development Board (bottom view)

The board has many features that allow users to implement a wide range of designed circuits, from simple circuits to various multimedia projects.

The following hardware is provided on the board:

FPGA Device

- Cyclone V SoC 5CSXFC6D6F31 Device
- Dual-core ARM Cortex-A9 (HPS)
- 110K Programmable Logic Elements
- 5,140 Kbits embedded memory
- 6 Fractional PLLs
- 2 Hard Memory Controllers
- 3.125G Transceivers



Configuration and Debug

- Quad Serial Configuration device – EPCQ256 on FPGA
- On-Board USB Blaster II (micro USB type B connector)

Memory Device

- 1GB (2x256MBx16) DDR3 SDRAM on FPGA
- 1GB (2x256MBx16) DDR3 SDRAM on HPS
- 128MB QSPI Flash on HPS
- Micro SD Card Socket on HPS

Communication

- USB 2.0 OTG (ULPI interface with micro USB type AB connector)
- USB to UART (micro USB type B connector)
- 10/100/1000 Ethernet

Connectors

- One HSMC (8-channel Transceivers, Configurable I/O standards 1.5/1.8/2.5/3.3V)
- One LTC connector (One Serial Peripheral Interface (SPI) Master ,one I2C and one GPIO interface)

Display

- 24-bit VGA DAC
- 128x64 dots LCD Module with Backlight

Audio

- 24-bit CODEC, Line-in, line-out, and microphone-in jacks

Switches, Buttons and LEDs

- 8 User Keys (FPGA x4 ; HPS x 4)
- 8 User Switches (FPGA x4 ; HPS x 4)
- 8 User LEDs (FPGA x4 ; HPS x 4)
- 2 HPS Reset Buttons (HPS_RSET_n and HPS_WARM_RST_n)



Sensors

- G-Sensor on HPS
- Temperature Sensor on FPGA

Power

- 12V DC input

2.2 Block Diagram of the SoCKit Board

Figure 2-3 gives the block diagram of the board. To provide maximum flexibility for the user, all connections are made through the Cyclone V SoC FPGA device. Thus, the user can configure the FPGA to implement any system design.

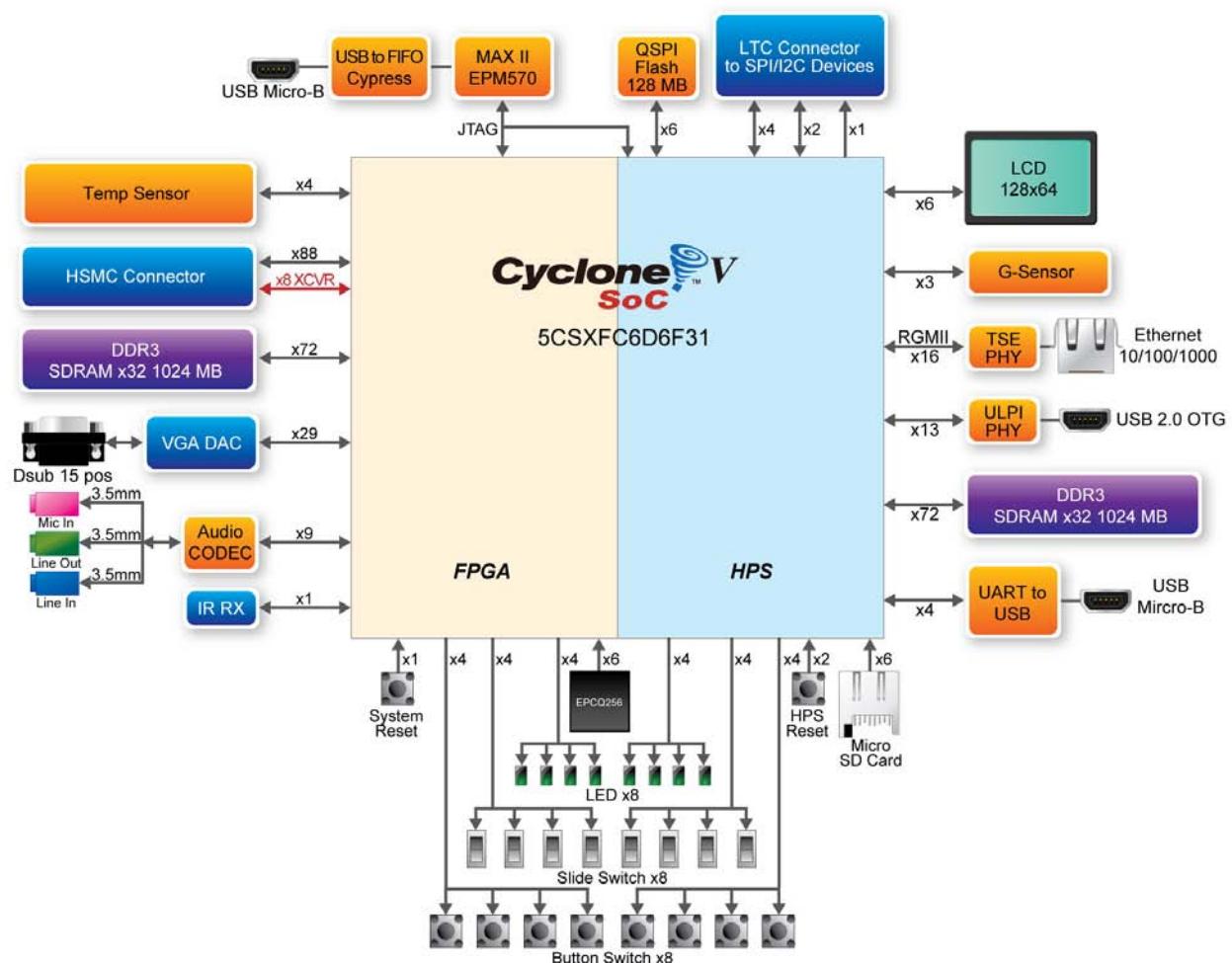


Figure 2-3 Board Block Diagram



Chapter 3

Using the SoCKit Board

This chapter gives instructions for using the board and describes each of its peripherals.

3.1 Board Setup Components

The SoCKit includes several jumpers, switches, etc. that control various system functions including JTAG chain, HSMC I/O voltage control, HPS boot source select, and others. This section will explain the settings and functions in detail.

3.1.1 JTAG Chain and Setup Switches

The SoCKit allows users to access the FPGA, HPS debug, or other JTAG chain devices via the on-board USB Blaster II. [Figure 3-1](#) shows the JTAG chain. Users can control whether the HPS or HSMC connector is included in the JTAG chain via SW4 (See [Figure 3-2](#)), where [Table 3-1](#) lists the configuration details

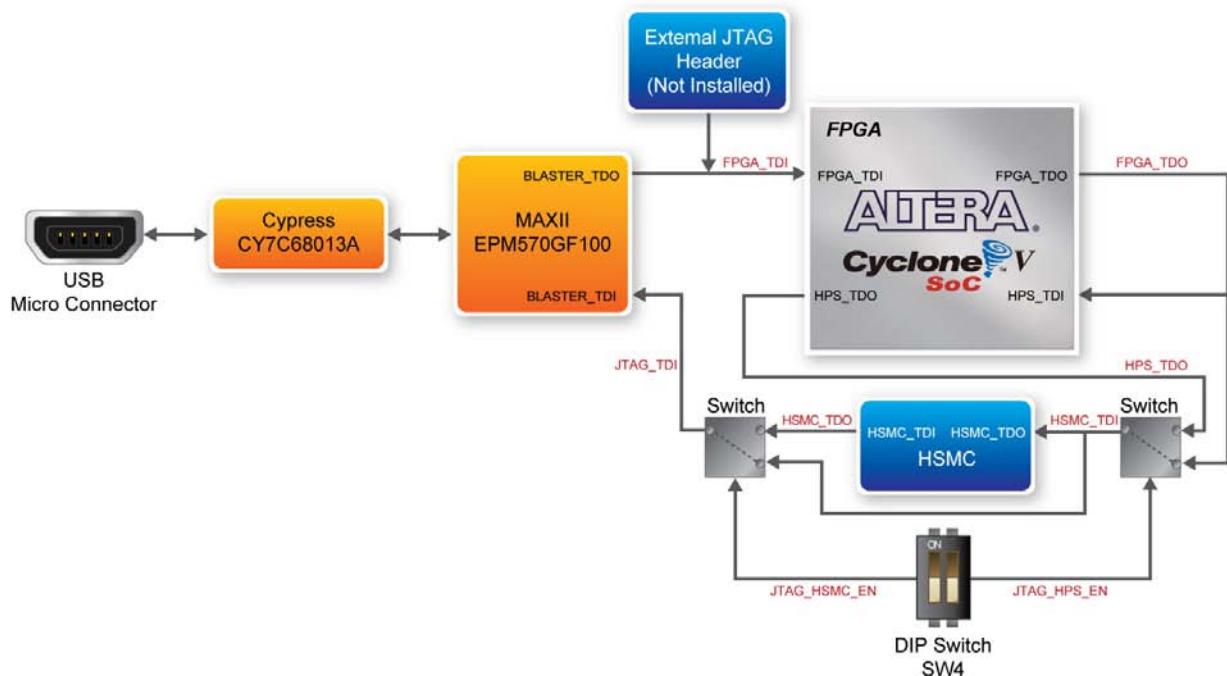


Figure 3-1 The JTAG chain on the board

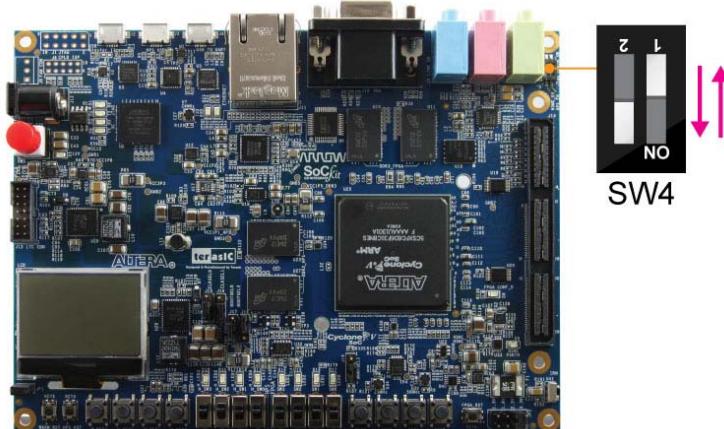


Figure 3-2 JTAG Chain and Setup Switches

Table 3-1 SW4 JTAG Control DIP Switch

Board Reference	Signal Name	Description	Default
SW4.1	JTAG_HPS_EN	On: Bypass HPS Off: HPS In-chain	Off
SW4.2	JTAG_HSMC_EN	On: Bypass HSMC Off: HSMC In-chain	On

3.1.2 FPGA Configuration Mode Switch

The Dipswitch SW6 (See **Figure 3-3**) can set the MSEL pins to decide the FPGA configuration modes. **Table 3-2** shows the switch controls and descriptions. **Table 3-3** gives the MSEL pins setting for each configuration scheme of Cyclone V devices. FPGA default works in ASx4 mode. However, once the FPGA is in AS x4 mode, and after successfully configuring the FPGA via the EPCQ256, the SoCKit will be unable to boot Linux from the SD card or other devices. Please switch SW6 to another mode (i.e. MSEL[0:4] = 00001) to enable normal operations of Linux.

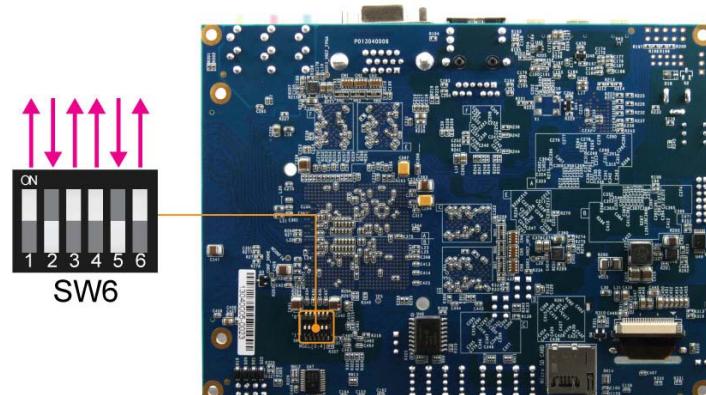


Figure 3-3 FPGA Configuration Mode Switch

Table 3-2 SW6 FPGA Configuration Mode Switch

Board Reference	Signal Name	Description	Default
SW6.1	MSEL0		On
SW6.2	MSEL1		Off
SW6.3	MSEL2		On
SW6.4	MSEL3		On
SW6.5	MSEL4		Off
SW6.6	N/A		N/A

Table 3-3 MSEL pin Settings for each Scheme of Cyclone V Device

Configuration Scheme	Compression Feature	Design Security Feature	POR Delay	Valid MSEL[4:0]
FPPx8	Disabled	Disabled	Fast	10100
			Standard	11000
	Disabled	Enabled	Fast	10101

			Standard	11001
FPPx16	Enabled	Disabled	Fast	10110
			Standard	11010
			Fast	00000
PS	Enabled/ Disabled	Enabled	Standard	00100
			Fast	00001
			Standard	00101
AS(X1 and X4)	Enabled/ Disabled	Disabled	Fast	00010
			Standard	00110
			Fast	10010
			Standard	10011

3.1.3 HPS BOOTSEL and CLKSEL Setting Headers

The processor in the HPS can be boot from many sources such as the SD card, QSPI Flash or FPGA. Selecting the boot source for the HPS can be set using the BOOTSEL jumpers (J17~J19, See [Figure 3-4](#)) and CLKSEL jumpers (J15~J16, See [Figure 3-5](#)). [Table 3-4](#) lists BOOTSEL and CLKSEL settings. [Table 3-5](#) lists the settings for selecting a suitable boot source.

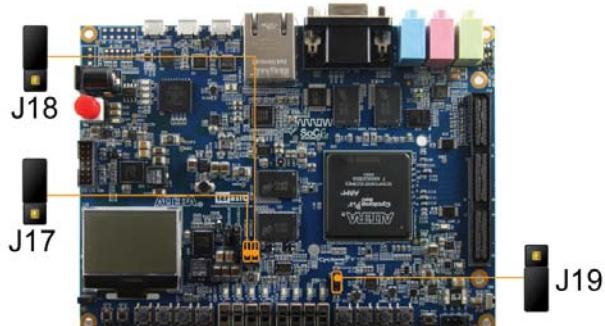


Figure 3-4 HPS BOOTSEL Setting Headers

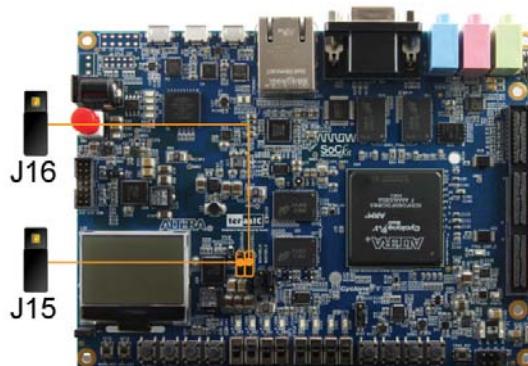


Figure 3-5 HPS CLKSEL Setting Headers

Table 3-4 HPS BOOTSEL and CLKSEL Setting Headers

Board Reference	Signal Name	Setting	Default
J17	BOOTSEL0	Short Pin 1 and 2: Logic 1 Short Pin 2 and 3: Logic 0	Short Pin 1 and 2
J19	BOOTSEL1	Short Pin 1 and 2: Logic 1 Short Pin 2 and 3: Logic 0	Short Pin 2 and 3
J18	BOOTSEL2	Short Pin 1 and 2: Logic 1 Short Pin 2 and 3: Logic 0	Short Pin 1 and 2
J15	CLKSEL0	Short Pin 1 and 2: Logic 1 Short Pin 2 and 3: Logic 0	Short Pin 2 and 3
J16	CLKSEL1	Short Pin 1 and 2: Logic 1 Short Pin 2 and 3: Logic 0	Short Pin 2 and 3

Table 3-5 BOOTSEL[2:0] Setting Values and Flash Device Selection

BOOTSEL[2:0] Setting Value	Flash Device
000	Reserved
001	FPGA (HPS-to-FPGA bridge)
010	1.8 V NAND Flash memory (*1)
011	3.0 V NAND Flash memory(*1)
100	1.8 V SD/MMC Flash memory(*1)
101	3.0 V SD/MMC Flash memory
110	1.8 V SPI or quad SPI Flash memory(*1)
111	3.0 V SPI or quad SPI Flash memory

(*1) : Not supported on SoCKit board

3.1.4 HSMC VCCIO Voltage Level Setting Header

On the SoCKit, the I/O standards of the FPGA/HSMC pins can be adjusted via JP2 (See [Figure 3-6](#)). Adjustable standards allow even more flexibility and selection of daughter cards or interconnect devices.

The HSMC connector's default standard is 2.5V. Users must ensure that the voltage standards for both the main board and daughter card are the same, or damage/incompatibility may occur.

Table 3-6 lists JP2 settings.



Figure 3-6 HSMC VCCIO Voltage Level Setting Header

Table 3-6 JP2 Header Setting for Different I/O Standard

<i>JP2 Jumper Setting</i>	<i>I/O Voltage of HSMC Connector</i>
Short Pin 1 and 2	1.5V
Short Pin 3 and 4	1.8V
Short Pin 5 and 6	2.5V (Default)
Short Pin 7 and 8	3.3V

Note:

1. JP2 only allows for one jumper at one time.
2. If no jumper is attached on JP2, the voltage standard will default to 1.5V

3.2 Board Status Elements

The board includes status LEDs. Please refer to [Table 3-7](#) for the status of the LED indicator.

Table 3-7 LED Indicators

Board Reference	LED Name	Description
D5	12-V Power	Illuminates when 12-V power is active.
TXD	UART TXD	Illuminates when data from FT232R to USB Host.
RXD	UART RXD	Illuminates when data from USB Host to FT232R.
D9	HSMC PSNTN	Illuminates when connecting a daughter card on HSMC connector.
D1	JTAG_RX	Reserved
D2	JTAG_TX	
D3	SC_RX	
D4	SC_TX	

3.3 Board Reset Elements

The board equips two HPS reset circuits and one FPGA Device Clear button (See [Figure 3-7](#)). [Table 3-8](#) shows the buttons references and its descriptions. [Figure 3-8](#) shows the reset tree on the board.

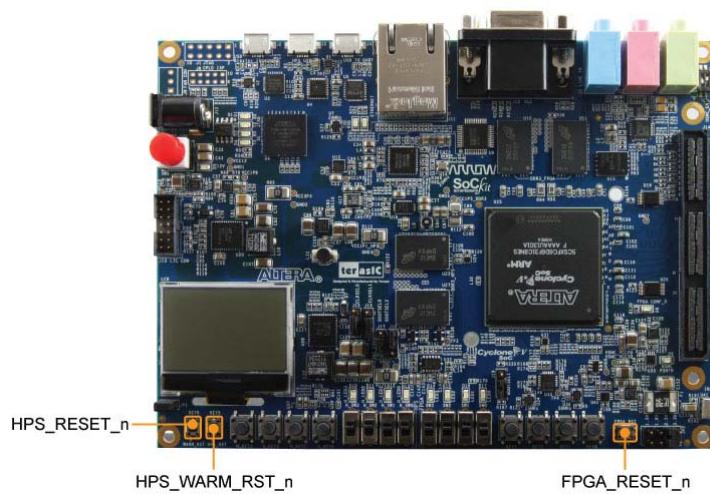


Figure 3-7 Board Reset Elements

Table 3-8 Reset Elements

Board Reference	Signal Name	Description
KEY5	HPS_RESET_n	Cold reset to the HPS , Ethernet PHY, UART and USB OTG device . Active low input that will reset all HPS logics that can be reset. Places the HPS in a default state sufficient for software to boot.
KEY6	HPS_WARM_RST_n	Warm reset to the HPS block. Active low input affects the system reset domains which allows debugging to operate.
KEY4	FPGA_RESET_n	This signal connects to the Cyclone V DEV_CLRn pin. When this pin is driven low, all the device registers are.

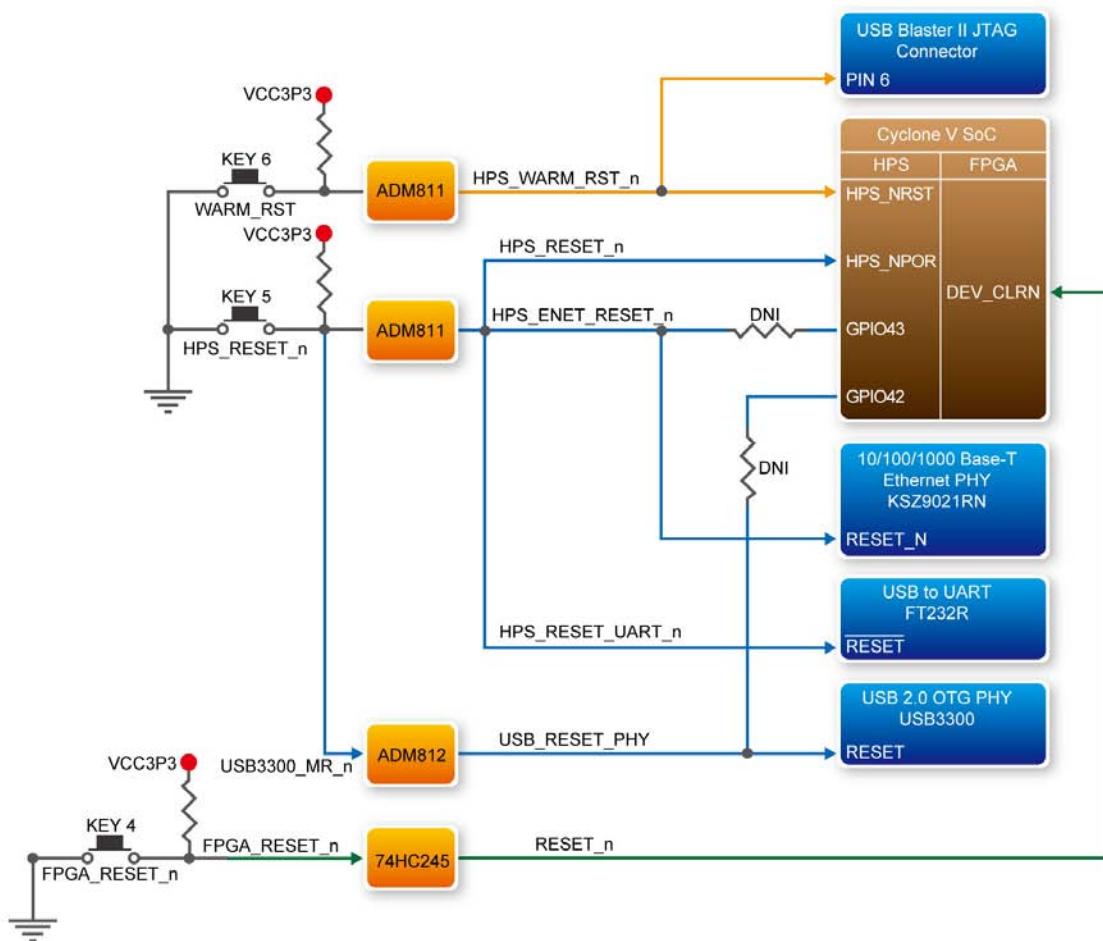


Figure 3-8 Reset Tree on the Development Board

3.4 Programming the Quad-Serial Configuration Device

- The board contains a quad serial configuration device (EPCQ256) that stores configuration data for the Cyclone V SoC FPGA. This configuration data is automatically loaded from the quad

serial configuration device chip into the FPGA when the board is powered up.

- To program the configuration device, users will need to use a Serial Flash Loader (SFL) function to program the quad serial configuration device via the JTAG interface. The FPGA-based SFL is a soft intellectual property (IP) core within the FPGA that bridges the JTAG and flash interfaces. The SFL mega-function is available from Quartus II software. **Figure 3-9** shows the programming method when adopting a SFL solution
- Please refer to *Chapter 6: Steps of Programming the Quad Serial Configuration Device* for the basic programming instruction on the serial configuration device

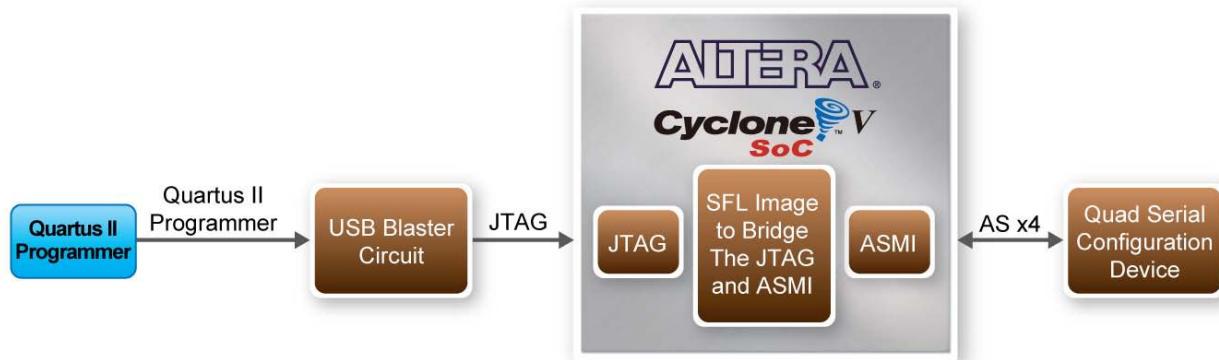


Figure 3-9 Programming a Quad Serial Configuration Device with the SFL Solution

Note: Before programming the quad serial configuration device, please set the FPGA configuration mode switch (SW6) to ASx4 mode.

3.5 Clock Circuits

Figure 3-10 is a diagram showing the default frequencies of all of the external clocks going to the Cyclone V SoC FPGA.

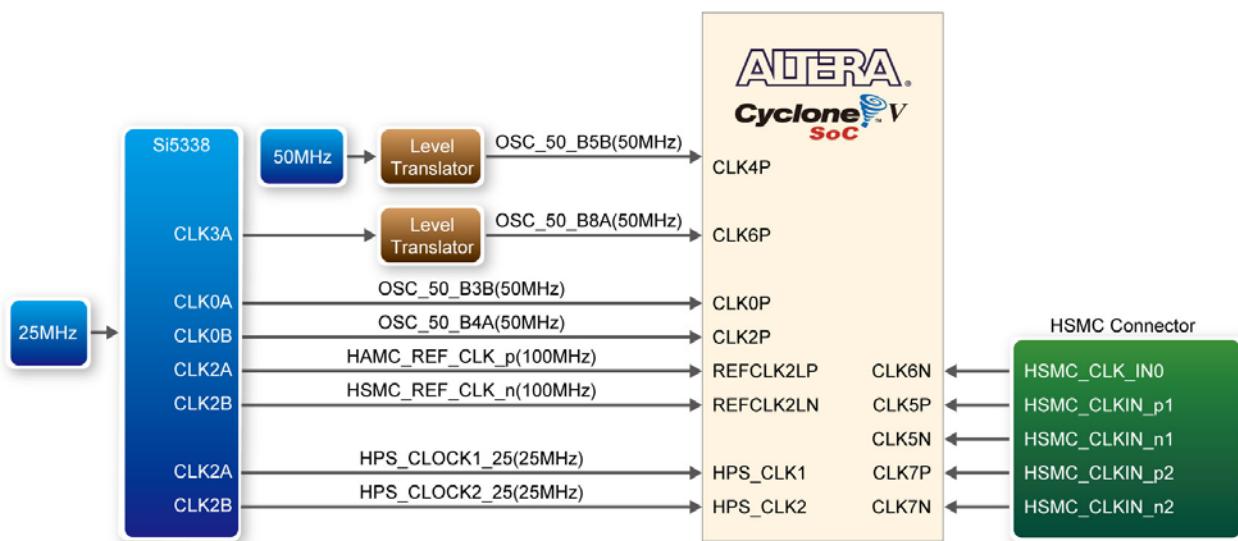


Figure 3-10 Block diagram of the clock distribution

3.6 Interface on FPGA

This section describes the interfaces to the FPGA. Users can control or monitor the different interfaces with user logic on the FPGA.

3.6.1 User Push-buttons, Switches and LED on FPGA

The board provides four push-button switches connected to FPGA as shown in [Figure 3-11](#). Each of these switches is debounced using a Schmitt Trigger circuit, as indicated in [Figure 3-12](#). The four outputs called KEY0, KEY1, KEY2, and KEY3 of the Schmitt Trigger devices are connected directly to the Cyclone V SoC FPGA. Each push-button switch provides a high logic level when it is not pressed, and provides a low logic level when depressed. Since the push-button switches are debounced, they are appropriate for using as clock or reset inputs in a circuit.

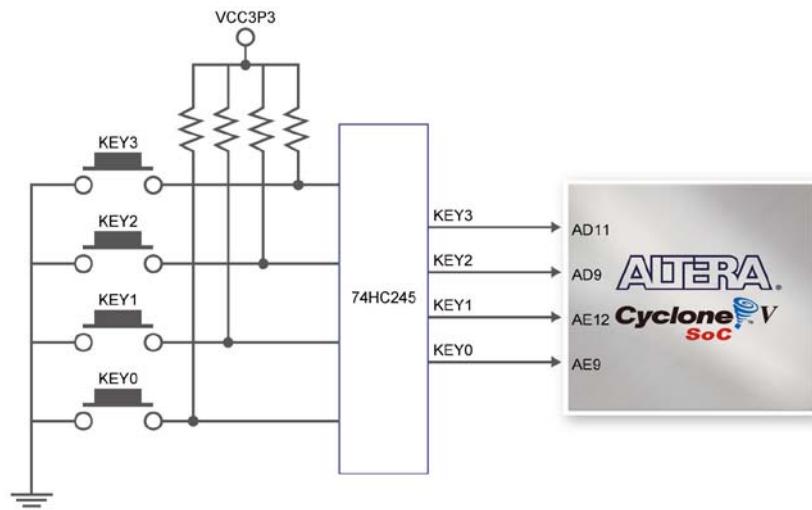


Figure 3-11 Connections between the push-button and Cyclone V SoC FPGA

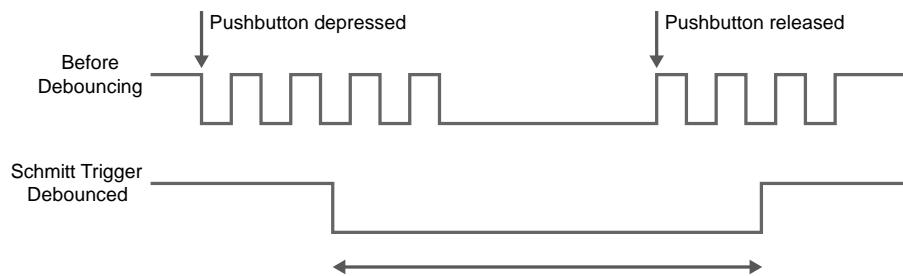


Figure 3-12 Switch debouncing

There are four slide switches connected to FPGA on the board (See [Figure 3-13](#)). These switches are not debounced, and are assumed for use as level-sensitive data inputs to a circuit. Each switch is connected directly to a pin on the Cyclone V SoC FPGA. When the switch is in the DOWN position (closest to the edge of the board), it provides a low logic level to the FPGA, and when the switch is in the UP position it provides a high logic level.

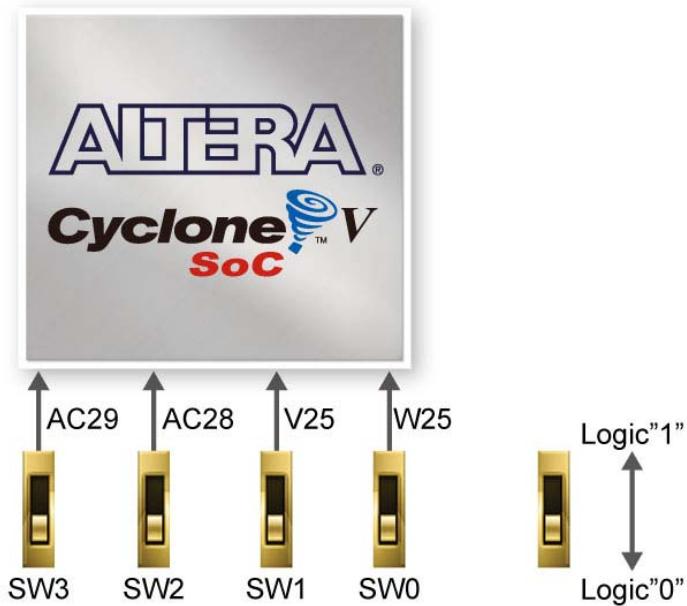


Figure 3-13 Connections between the slide switches and Cyclone V SoC FPGA

There are also four user-controllable LEDs connected to FPGA on the board. Each LED is driven directly by a pin on the Cyclone V SoC FPGA; driving its associated pin to a high logic level turns the LED on, and driving the pin low turns it off. **Figure 3-14** shows the connections between LEDs and Cyclone V SoC FPGA. **Table 3-9**, **Table 3-10** and **Table 3-11** list the pin assignments of these user interfaces.

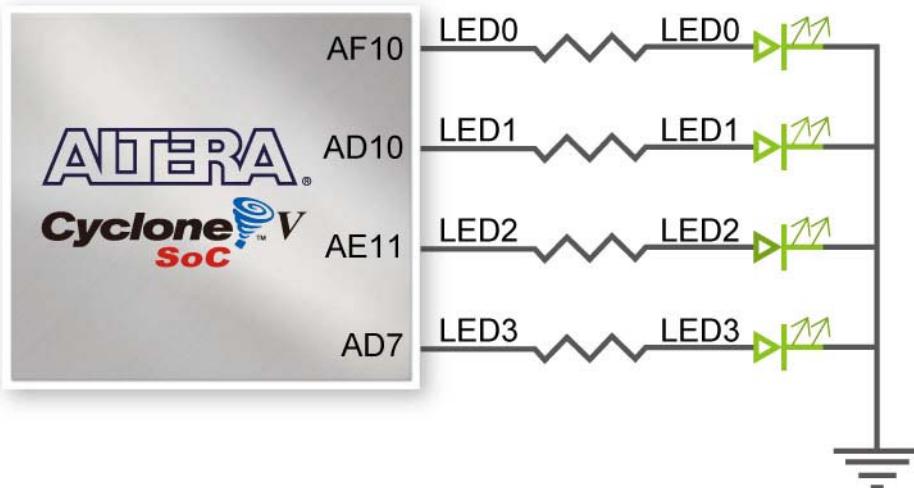


Figure 3-14 Connections between the LEDs and Cyclone V SoC FPGA

Table 3-9 Pin Assignments for Slide Switches

Signal Name	FPGA Pin No.	Description	I/O Standard
SW[0]	PIN_W25	Slide Switch[0]	2.5V
SW[1]	PIN_V25	Slide Switch[1]	2.5V
SW[2]	PIN_AC28	Slide Switch[2]	2.5V
SW[3]	PIN_AC29	Slide Switch[3]	2.5V

Table 3-10 Pin Assignments for Push-buttons

Signal Name	FPGA Pin No.	Description	I/O Standard
KEY[0]	PIN_AE9	Push-button[0]	3.3V
KEY[1]	PIN_AE12	Push-button[1]	3.3V
KEY[2]	PIN_AD9	Push-button[2]	3.3V
KEY[3]	PIN_AD11	Push-button[3]	3.3V

Table 3-11 Pin Assignments for LEDs

Signal Name	FPGA Pin No.	Description	I/O Standard
LED[0]	PIN_AF10	LED [0]	3.3V
LED[1]	PIN_AD10	LED [1]	3.3V
LED[2]	PIN_AE11	LED [2]	3.3V
LED[3]	PIN_AD7	LED [3]	3.3V

3.6.2 HSMC connector

The board contains a High Speed Mezzanine Card (HSMC) interface to provide a mechanism for extending the peripheral-set of an FPGA host board by means of add-on daughter cards, which can address today's high speed signaling requirements as well as low-speed device interface support. The HSMC interface support JTAG, clock outputs and inputs, high-speed serial I/O (transceivers), and single-ended or differential signaling. Signals on the HSMC port are shown in [Figure 3-15](#). [Table 3-12](#) shows the maximum power consumption of the daughter card that connects to HSMC port.

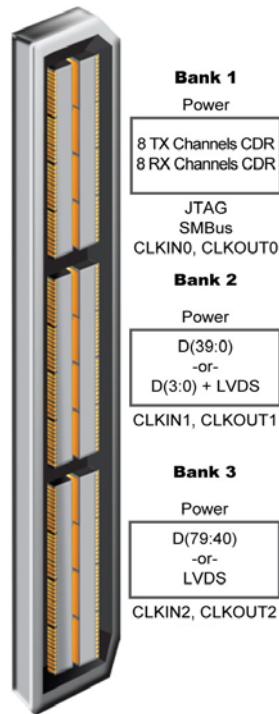


Figure 3-15 HSMC Signal Bank Diagram

Table 3-12 Power Supply of the HSMC

Supplied Voltage	Max. Current Limit
12V	1A
3.3V	1.5A

Table 3-13 Pin Assignments for HSMC connector

Signal Name	FPGA Pin No.	Description	I/O Standard
HSMC_CLK_IN0	PIN_J14	Dedicated clock input	Depend on JP2
HSMC_CLKIN_n1	PIN_AB27	LVDS RX or CMOS I/O or differential clock input	Depend on JP2
HSMC_CLKIN_n2	PIN_G15	LVDS RX or CMOS I/O or differential clock input	Depend on JP2
HSMC_CLKIN_p1	PIN_AA26	LVDS RX or CMOS I/O or differential clock input	Depend on JP2
HSMC_CLKIN_p2	PIN_H15	LVDS RX or CMOS I/O or differential clock input	Depend on JP2
HSMC_CLK_OUT0	PIN_AD29	Dedicated clock output	Depend on JP2
HSMC_CLKOUT_n1	PIN_E6	LVDS TX or CMOS I/O or differential clock input/output	Depend on JP2
HSMC_CLKOUT_n2	PIN_A10	LVDS TX or CMOS I/O or differential clock input/output	Depend on JP2
HSMC_CLKOUT_p1	PIN_E7	LVDS TX or CMOS I/O or	Depend on JP2



		differential clock input/output	
HSMC_CLKOUT_p2	PIN_A11	LVDS TX or CMOS I/O or differential clock input/output	Depend on JP2
HSMC_D[0]	PIN_C10	LVDS TX or CMOS I/O	Depend on JP2
HSMC_D[1]	PIN_H13	LVDS RX or CMOS I/O	Depend on JP2
HSMC_D[2]	PIN_C9	LVDS TX or CMOS I/O	Depend on JP2
HSMC_D[3]	PIN_H12	LVDS RX or CMOS I/O	Depend on JP2
HSMC_SCL	PIN_AA28	Management serial data	Depend on JP2
HSMC_SDA	PIN_AE29	Management serial clock	Depend on JP2
HSMC_GXB_RX_p[0]	PIN_AE2	Transceiver RX bit 0	1.5-V PCML
HSMC_GXB_RX_p[1]	PIN_AC2	Transceiver RX bit 1	1.5-V PCML
HSMC_GXB_RX_p[2]	PIN_AA2	Transceiver RX bit 2	1.5-V PCML
HSMC_GXB_RX_p[3]	PIN_W2	Transceiver RX bit 3	1.5-V PCML
HSMC_GXB_RX_p[4]	PIN_U2	Transceiver RX bit 4	1.5-V PCML
HSMC_GXB_RX_p[5]	PIN_R2	Transceiver RX bit 5	1.5-V PCML
HSMC_GXB_RX_p[6]	PIN_N2	Transceiver RX bit 6	1.5-V PCML
HSMC_GXB_RX_p[7]	PIN_J2	Transceiver RX bit 7	1.5-V PCML
HSMC_GXB_TX_p[0]	PIN_AD4	Transceiver TX bit 0	1.5-V PCML
HSMC_GXB_TX_p[1]	PIN_AB4	Transceiver TX bit 1	1.5-V PCML
HSMC_GXB_TX_p[2]	PIN_Y4	Transceiver TX bit 2	1.5-V PCML
HSMC_GXB_TX_p[3]	PIN_V4	Transceiver TX bit 3	1.5-V PCML
HSMC_GXB_TX_p[4]	PIN_T4	Transceiver TX bit 4	1.5-V PCML
HSMC_GXB_TX_p[5]	PIN_P4	Transceiver TX bit 5	1.5-V PCML
HSMC_GXB_TX_p[6]	PIN_M4	Transceiver TX bit 6	1.5-V PCML
HSMC_GXB_TX_p[7]	PIN_H4	Transceiver TX bit 7	1.5-V PCML
HSMC_GXB_RX_n[0]	PIN_AE1	Transceiver RX bit 0n	1.5-V PCML
HSMC_GXB_RX_n[1]	PIN_AC1	Transceiver RX bit 1n	1.5-V PCML
HSMC_GXB_RX_n[2]	PIN_AA1	Transceiver RX bit 2n	1.5-V PCML
HSMC_GXB_RX_n[3]	PIN_W1	Transceiver RX bit 3n	1.5-V PCML
HSMC_GXB_RX_n[4]	PIN_U1	Transceiver RX bit 4n	1.5-V PCML
HSMC_GXB_RX_n[5]	PIN_R1	Transceiver RX bit 5n	1.5-V PCML
HSMC_GXB_RX_n[6]	PIN_N1	Transceiver RX bit 6n	1.5-V PCML
HSMC_GXB_RX_n[7]	PIN_J1	Transceiver RX bit 7n	1.5-V PCML
HSMC_GXB_TX_n[0]	PIN_AD3	Transceiver TX bit 0n	1.5-V PCML
HSMC_GXB_TX_n[1]	PIN_AB3	Transceiver TX bit 1n	1.5-V PCML
HSMC_GXB_TX_n[2]	PIN_Y3	Transceiver TX bit 2n	1.5-V PCML
HSMC_GXB_TX_n[3]	PIN_V3	Transceiver TX bit 3n	1.5-V PCML
HSMC_GXB_TX_n[4]	PIN_T3	Transceiver TX bit 4n	1.5-V PCML
HSMC_GXB_TX_n[5]	PIN_P3	Transceiver TX bit 5n	1.5-V PCML
HSMC_GXB_TX_n[6]	PIN_M3	Transceiver TX bit 6n	1.5-V PCML
HSMC_GXB_TX_n[7]	PIN_H3	Transceiver TX bit 7n	1.5-V PCML
HSMC_RX_n[0]	PIN_G11	LVDS RX bit 0n or CMOS I/O	Depend on JP2
HSMC_RX_n[1]	PIN_J12	LVDS RX bit 1n or CMOS I/O	Depend on JP2
HSMC_RX_n[2]	PIN_F10	LVDS RX bit 2n or CMOS I/O	Depend on JP2
HSMC_RX_n[3]	PIN_J9	LVDS RX bit 3n or CMOS I/O	Depend on JP2
HSMC_RX_n[4]	PIN_K8	LVDS RX bit 4n or CMOS I/O	Depend on JP2



HSMC_RX_n[5]	PIN_H7	LVDS RX bit 5n or CMOS I/O	Depend on JP2
HSMC_RX_n[6]	PIN_G8	LVDS RX bit 6n or CMOS I/O	Depend on JP2
HSMC_RX_n[7]	PIN_F8	LVDS RX bit 7n or CMOS I/O	Depend on JP2
HSMC_RX_n[8]	PIN_E11	LVDS RX bit 8n or CMOS I/O	Depend on JP2
HSMC_RX_n[9]	PIN_B5	LVDS RX bit 9n or CMOS I/O	Depend on JP2
HSMC_RX_n[10]	PIN_D9	LVDS RX bit 10n or CMOS I/O	Depend on JP2
HSMC_RX_n[11]	PIN_D12	LVDS RX bit 11n or CMOS I/O	Depend on JP2
HSMC_RX_n[12]	PIN_D10	LVDS RX bit 12n or CMOS I/O	Depend on JP2
HSMC_RX_n[13]	PIN_B12	LVDS RX bit 13n or CMOS I/O	Depend on JP2
HSMC_RX_n[14]	PIN_E13	LVDS RX bit 14n or CMOS I/O	Depend on JP2
HSMC_RX_n[15]	PIN_G13	LVDS RX bit 15n or CMOS I/O	Depend on JP2
HSMC_RX_n[16]	PIN_F14	LVDS RX bit 16n or CMOS I/O	Depend on JP2
HSMC_RX_p[0]	PIN_G12	LVDS RX bit 0 or CMOS I/O	Depend on JP2
HSMC_RX_p[1]	PIN_K12	LVDS RX bit 1 or CMOS I/O	Depend on JP2
HSMC_RX_p[2]	PIN_G10	LVDS RX bit 2 or CMOS I/O	Depend on JP2
HSMC_RX_p[3]	PIN_J10	LVDS RX bit 3 or CMOS I/O	Depend on JP2
HSMC_RX_p[4]	PIN_K7	LVDS RX bit 4 or CMOS I/O	Depend on JP2
HSMC_RX_p[5]	PIN_J7	LVDS RX bit 5 or CMOS I/O	Depend on JP2
HSMC_RX_p[6]	PIN_H8	LVDS RX bit 6 or CMOS I/O	Depend on JP2
HSMC_RX_p[7]	PIN_F9	LVDS RX bit 7 or CMOS I/O	Depend on JP2
HSMC_RX_p[8]	PIN_F11	LVDS RX bit 8 or CMOS I/O	Depend on JP2
HSMC_RX_p[9]	PIN_B6	LVDS RX bit 9 or CMOS I/O	Depend on JP2
HSMC_RX_p[10]	PIN_E9	LVDS RX bit 10 or CMOS I/O	Depend on JP2
HSMC_RX_p[11]	PIN_E12	LVDS RX bit 11 or CMOS I/O	Depend on JP2
HSMC_RX_p[12]	PIN_D11	LVDS RX bit 12 or CMOS I/O	Depend on JP2
HSMC_RX_p[13]	PIN_C13	LVDS RX bit 13 or CMOS I/O	Depend on JP2
HSMC_RX_p[14]	PIN_F13	LVDS RX bit 14 or CMOS I/O	Depend on JP2
HSMC_RX_p[15]	PIN_H14	LVDS RX bit 15 or CMOS I/O	Depend on JP2
HSMC_RX_p[16]	PIN_F15	LVDS RX bit 16 or CMOS I/O	Depend on JP2
HSMC_TX_n[0]	PIN_A8	LVDS TX bit 0n or CMOS I/O	Depend on JP2
HSMC_TX_n[1]	PIN_D7	LVDS TX bit 1n or CMOS I/O	Depend on JP2
HSMC_TX_n[2]	PIN_F6	LVDS TX bit 2n or CMOS I/O	Depend on JP2
HSMC_TX_n[3]	PIN_C5	LVDS TX bit 3n or CMOS I/O	Depend on JP2
HSMC_TX_n[4]	PIN_C4	LVDS TX bit 4n or CMOS I/O	Depend on JP2
HSMC_TX_n[5]	PIN_E2	LVDS TX bit 5n or CMOS I/O	Depend on JP2
HSMC_TX_n[6]	PIN_D4	LVDS TX bit 6n or CMOS I/O	Depend on JP2
HSMC_TX_n[7]	PIN_B3	LVDS TX bit 7n or CMOS I/O	Depend on JP2
HSMC_TX_n[8]	PIN_D1	LVDS TX bit 8n or CMOS I/O	Depend on JP2
HSMC_TX_n[9]	PIN_C2	LVDS TX bit 9n or CMOS I/O	Depend on JP2
HSMC_TX_n[10]	PIN_B1	LVDS TX bit 10n or CMOS I/O	Depend on JP2
HSMC_TX_n[11]	PIN_A3	LVDS TX bit 11n or CMOS I/O	Depend on JP2
HSMC_TX_n[12]	PIN_A5	LVDS TX bit 12n or CMOS I/O	Depend on JP2
HSMC_TX_n[13]	PIN_B7	LVDS TX bit 13n or CMOS I/O	Depend on JP2
HSMC_TX_n[14]	PIN_B8	LVDS TX bit 14n or CMOS I/O	Depend on JP2
HSMC_TX_n[15]	PIN_B11	LVDS TX bit 15n or CMOS I/O	Depend on JP2
HSMC_TX_n[16]	PIN_A13	LVDS TX bit 16n or CMOS I/O	Depend on JP2

HSMC_TX_p[0]	PIN_A9	LVDS TX bit 0 or CMOS I/O	Depend on JP2
HSMC_TX_p[1]	PIN_E8	LVDS TX bit 1 or CMOS I/O	Depend on JP2
HSMC_TX_p[2]	PIN_G7	LVDS TX bit 2 or CMOS I/O	Depend on JP2
HSMC_TX_p[3]	PIN_D6	LVDS TX bit 3 or CMOS I/O	Depend on JP2
HSMC_TX_p[4]	PIN_D5	LVDS TX bit 4 or CMOS I/O	Depend on JP2
HSMC_TX_p[5]	PIN_E3	LVDS TX bit 5 or CMOS I/O	Depend on JP2
HSMC_TX_p[6]	PIN_E4	LVDS TX bit 6 or CMOS I/O	Depend on JP2
HSMC_TX_p[7]	PIN_C3	LVDS TX bit 7 or CMOS I/O	Depend on JP2
HSMC_TX_p[8]	PIN_E1	LVDS TX bit 8 or CMOS I/O	Depend on JP2
HSMC_TX_p[9]	PIN_D2	LVDS TX bit 9 or CMOS I/O	Depend on JP2
HSMC_TX_p[10]	PIN_B2	LVDS TX bit 10 or CMOS I/O	Depend on JP2
HSMC_TX_p[11]	PIN_A4	LVDS TX bit 11 or CMOS I/O	Depend on JP2
HSMC_TX_p[12]	PIN_A6	LVDS TX bit 12 or CMOS I/O	Depend on JP2
HSMC_TX_p[13]	PIN_C7	LVDS TX bit 13 or CMOS I/O	Depend on JP2
HSMC_TX_p[14]	PIN_C8	LVDS TX bit 14 or CMOS I/O	Depend on JP2
HSMC_TX_p[15]	PIN_C12	LVDS TX bit 15 or CMOS I/O	Depend on JP2
HSMC_TX_p[16]	PIN_B13	LVDS TX bit 16 or CMOS I/O	Depend on JP2

3.6.3 Audio CODEC

The board provides high-quality 24-bit audio via the Analog Devices SSM2603 audio CODEC (Encoder/Decoder). This chip supports microphone-in, line-in, and line-out ports, with a sample rate adjustable from 8 kHz to 96 kHz. The SSM2603 is controlled via a serial I2C bus interface, which is connected to pins on the Cyclone V SoC FPGA. A schematic diagram of the audio circuitry is shown in [Figure 3-16](#). Detailed information for using the SSM2603 codec is available in its datasheet, which can be found on the manufacturer's website, or in the Datasheets\Audio CODEC folder on the SoCKit System CD

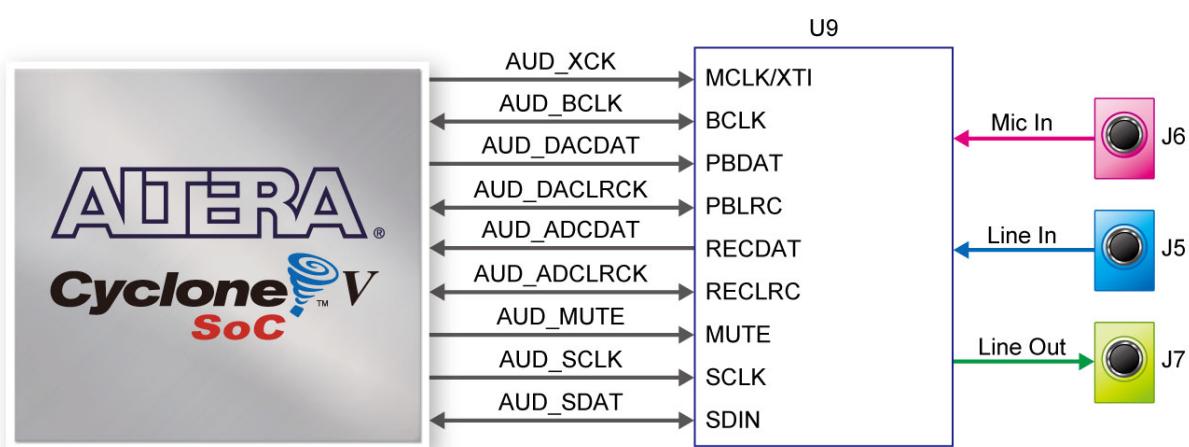


Figure 3-16 Connections between FPGA and Audio CODEC

Table 3-14 Pin Assignments for Audio CODEC

Signal Name	FPGA Pin No.	Description	I/O Standard
AUD_ADCLRCK	PIN_AG30	Audio CODEC ADC LR Clock	3.3V
AUD_ADCDAT	PIN_AC27	Audio CODEC ADC Data	3.3V
AUD_DACLRCK	PIN_AH4	Audio CODEC DAC LR Clock	3.3V
AUD_DACDAT	PIN_AG3	Audio CODEC DAC Data	3.3V
AUD_XCK	PIN_AC9	Audio CODEC Chip Clock	3.3V
AUD_BCLK	PIN_AE7	Audio CODEC Bit-Stream Clock	3.3V
AUD_I2C_SCLK	PIN_AH30	I2C Clock	3.3V
AUD_I2C_SDAT	PIN_AF30	I2C Data	3.3V
AUD_MUTE	PIN_AD26	DAC Output Mute, Active Low	3.3V

3.6.4 VGA

The board includes a 15-pin D-SUB connector for VGA output. The VGA synchronization signals are provided directly from the Cyclone V SoC FPGA, and the Analog Devices ADV7123 triple 10-bit high-speed video DAC (only the higher 8-bits are used) is used to produce the analog data signals (red, green, and blue). It could support the SXGA standard (1280*1024) with a bandwidth of 100MHz. [Figure 3-17](#) gives the associated schematic.

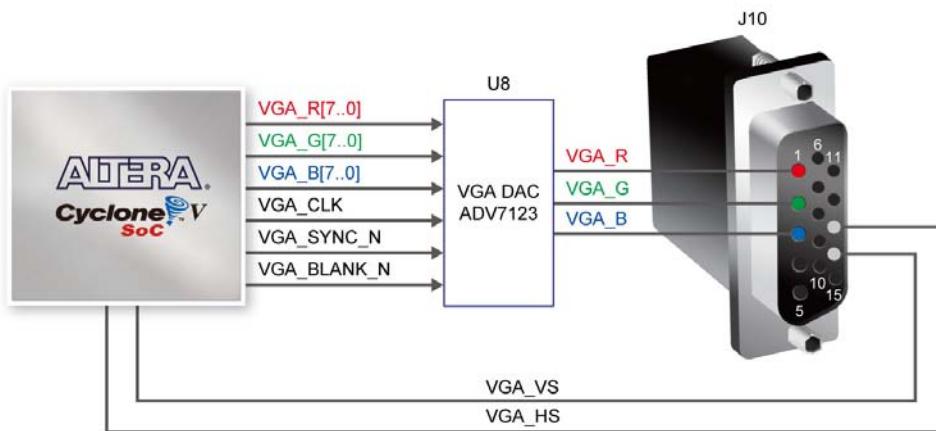


Figure 3-17 VGA Connections between FPGA and VGA

The timing specification for VGA synchronization and RGB (red, green, blue) data can be found on various educational website (for example, search for “VGA signal timing”). [Figure 3-18](#) illustrates the basic timing requirements for each row (horizontal) that is displayed on a VGA monitor. An active-low pulse of specific duration (time (a) in the figure) is applied to the horizontal synchronization (hsync) input of the monitor, which signifies the end of one row of data and the

start of the next. The data (RGB) output to the monitor must be off (driven to 0 V) for a time period called the back porch (b) after the hsync pulse occurs, which is followed by the display interval (c). During the data display interval the RGB data drives each pixel in turn across the row being displayed. Finally, there is a time period called the front porch (d) where the RGB signals must again be off before the next hsync pulse can occur. The timing of the vertical synchronization (vsync) is similar as shown in [Figure 3-18](#), except that a vsync pulse signifies the end of one frame and the start of the next, and the data refers to the set of rows in the frame (horizontal timing). [Table 3-15](#) and [Table 3-16](#) show different resolutions and durations of time periods a, b, c, and d for both horizontal and vertical timing.

Detailed information for using the ADV7123 video DAC is available in its datasheet, which can be found on the manufacturer's website, or in the Datasheets\VIDEO DAC folder on the SoCKit System CD. The pin assignments between the Cyclone V SoC FPGA and the ADV7123 are listed in [Table 3-17](#)

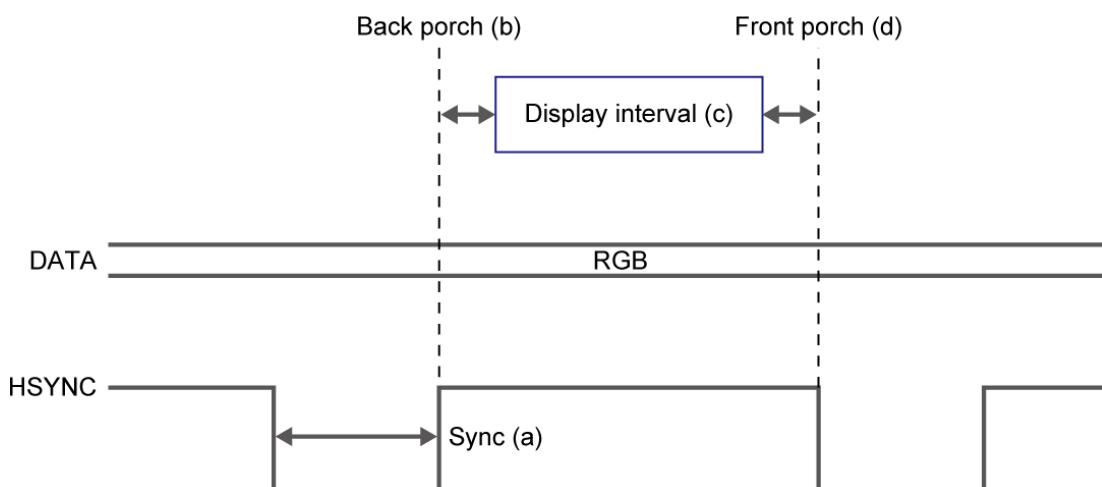


Figure 3-18 VGA horizontal timing specification

Table 3-15 VGA Horizontal Timing Specification

VGA mode		Horizontal Timing Spec				
Configuration	Resolution(HxV)	a(us)	b(us)	c(us)	d(us)	Pixel clock(MHz)
VGA(60Hz)	640x480	3.8	1.9	25.4	0.6	25
VGA(85Hz)	640x480	1.6	2.2	17.8	1.6	36
SVGA(60Hz)	800x600	3.2	2.2	20	1	40
SVGA(75Hz)	800x600	1.6	3.2	16.2	0.3	49
SVGA(85Hz)	800x600	1.1	2.7	14.2	0.6	56
XGA(60Hz)	1024x768	2.1	2.5	15.8	0.4	65
XGA(70Hz)	1024x768	1.8	1.9	13.7	0.3	75
XGA(85Hz)	1024x768	1.0	2.2	10.8	0.5	95
1280x1024(60Hz)	1280x1024	1.0	2.3	11.9	0.4	108



Table 3-16 VGA Vertical Timing Specification

VGA mode		Vertical Timing Spec				
Configuration	Resolution(HxV)	a(lines)	b(lines)	c(lines)	d(lines)	Pixel clock(MHz)
VGA(60Hz)	640x480	2	33	480	10	25
VGA(85Hz)	640x480	3	25	480	1	36
SVGA(60Hz)	800x600	4	23	600	1	40
SVGA(75Hz)	800x600	3	21	600	1	49
SVGA(85Hz)	800x600	3	27	600	1	56
XGA(60Hz)	1024x768	6	29	768	3	65
XGA(70Hz)	1024x768	6	29	768	3	75
XGA(85Hz)	1024x768	3	36	768	1	95
1280x1024(60Hz)	1280x1024	3	38	1024	1	108

Table 3-17 Pin Assignments for VGA

Signal Name	FPGA Pin No.	Description	I/O Standard
VGA_R[0]	PIN_AG5	VGA Red[0]	3.3V
VGA_R[1]	PIN_AA12	VGA Red[1]	3.3V
VGA_R[2]	PIN_AB12	VGA Red[2]	3.3V
VGA_R[3]	PIN_AF6	VGA Red[3]	3.3V
VGA_R[4]	PIN_AG6	VGA Red[4]	3.3V
VGA_R[5]	PIN_AJ2	VGA Red[5]	3.3V
VGA_R[6]	PIN_AH5	VGA Red[6]	3.3V
VGA_R[7]	PIN_AJ1	VGA Red[7]	3.3V
VGA_G[0]	PIN_Y21	VGA Green[0]	3.3V
VGA_G[1]	PIN_AA25	VGA Green[1]	3.3V
VGA_G[2]	PIN_AB26	VGA Green[2]	3.3V
VGA_G[3]	PIN_AB22	VGA Green[3]	3.3V
VGA_G[4]	PIN_AB23	VGA Green[4]	3.3V
VGA_G[5]	PIN_AA24	VGA Green[5]	3.3V
VGA_G[6]	PIN_AB25	VGA Green[6]	3.3V
VGA_G[7]	PIN_AE27	VGA Green[7]	3.3V
VGA_B[0]	PIN_AE28	VGA Blue[0]	3.3V
VGA_B[1]	PIN_Y23	VGA Blue[1]	3.3V
VGA_B[2]	PIN_Y24	VGA Blue[2]	3.3V
VGA_B[3]	PIN_AG28	VGA Blue[3]	3.3V
VGA_B[4]	PIN_AF28	VGA Blue[4]	3.3V
VGA_B[5]	PIN_V23	VGA Blue[5]	3.3V
VGA_B[6]	PIN_W24	VGA Blue[6]	3.3V
VGA_B[7]	PIN_AF29	VGA Blue[7]	3.3V
VGA_CLK	PIN_W20	VGA Clock	3.3V
VGA_BLANK_n	PIN_AH3	VGA BLANK	3.3V
VGA_HS	PIN_AD12	VGA H_SYNC	3.3V
VGA_VS	PIN_AC12	VGA V_SYNC	3.3V
VGA_SYNC_n	PIN_AG2	VGA SYNC	3.3V

3.6.5 IR Receiver

The board provides an infrared remote-control receiver module (model: IRM-V5XX/TR1), whose datasheet is offered in the Datasheets\IR_Receiver folder on SoCKit System CD. The accompanied remote controller with an encoding chip of uPD6121G is very suitable of generating expected infrared signals. **Figure 3-19** shows the related schematic of the IR receiver. **Table 3-18** shows the IR receiver interface pin assignments.

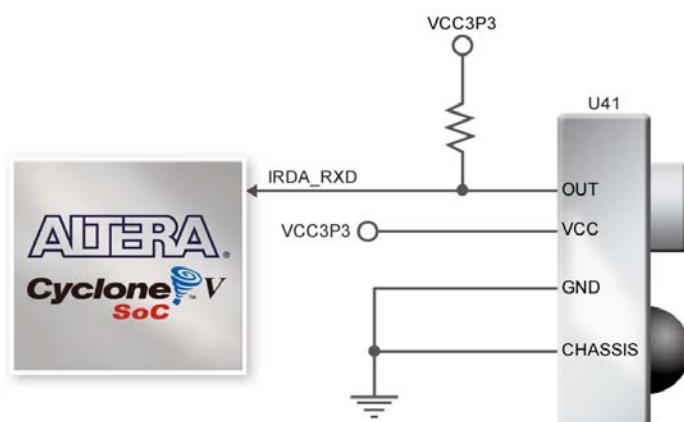


Figure 3-19 Connection between FPGA and IR

Table 3-18 Pin Assignments for IR

Signal Name	FPGA Pin No.	Description	I/O Standard
IRDA_RXD	PIN_AH2	IR Receiver	3.3V

3.6.6 DDR3 Memory on FPGA

The board supports 1GB of DDR3 SDRAM comprising of two x16 bit DDR3 devices on FPGA side. The DDR3 devices shipped with this board are running at 400MHz if the hard external memory interface is enabled, and at 300MHz if the hard external memory interface is not enabled. **Figure 3-20** shows the connections between the DDR3 and Cyclone V SoC FPGA. **Table 3-19** shows the DDR3 interface pin assignments.

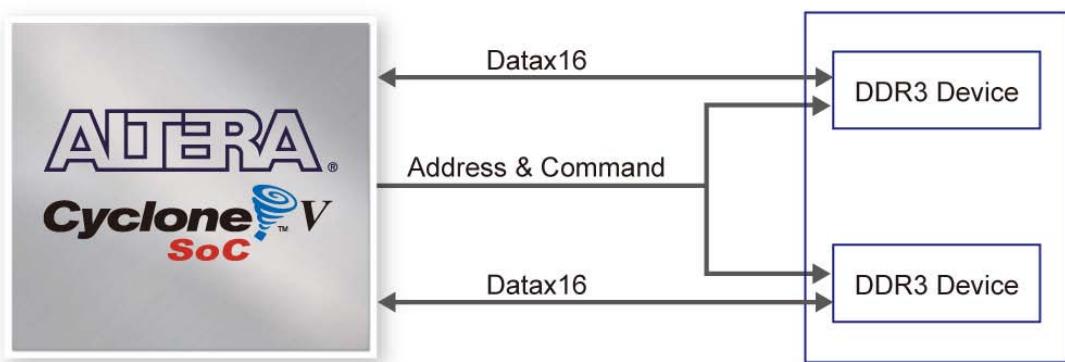


Figure 3-20 Connections between FPGA and DDR3

Table 3-19 Pin Assignments for DDR3

<i>Signal Name</i>	<i>FPGA Pin No.</i>	<i>Description</i>	<i>I/O Standard</i>
DDR3_A[0]	PIN_AJ14	DDR3 Address[0]	SSTL-15 Class I
DDR3_A[1]	PIN_AK14	DDR3 Address[1]	SSTL-15 Class I
DDR3_A[2]	PIN_AH12	DDR3 Address[2]	SSTL-15 Class I
DDR3_A[3]	PIN_AJ12	DDR3 Address[3]	SSTL-15 Class I
DDR3_A[4]	PIN_AG15	DDR3 Address[4]	SSTL-15 Class I
DDR3_A[5]	PIN_AH15	DDR3 Address[5]	SSTL-15 Class I
DDR3_A[6]	PIN_AK12	DDR3 Address[6]	SSTL-15 Class I
DDR3_A[7]	PIN_AK13	DDR3 Address[7]	SSTL-15 Class I
DDR3_A[8]	PIN_AH13	DDR3 Address[8]	SSTL-15 Class I
DDR3_A[9]	PIN_AH14	DDR3 Address[9]	SSTL-15 Class I
DDR3_A[10]	PIN_AJ9	DDR3 Address[10]	SSTL-15 Class I
DDR3_A[11]	PIN_AK9	DDR3 Address[11]	SSTL-15 Class I
DDR3_A[12]	PIN_AK7	DDR3 Address[12]	SSTL-15 Class I
DDR3_A[13]	PIN_AK8	DDR3 Address[13]	SSTL-15 Class I
DDR3_A[14]	PIN_AG12	DDR3 Address[14]	SSTL-15 Class I
DDR3_BA[0]	PIN_AH10	DDR3 Bank Address[0]	SSTL-15 Class I
DDR3_BA[1]	PIN_AJ11	DDR3 Bank Address[1]	SSTL-15 Class I
DDR3_BA[2]	PIN_AK11	DDR3 Bank Address[2]	SSTL-15 Class I
DDR3_CAS_n	PIN_AH7	DDR3 Column Address Strobe	SSTL-15 Class I
DDR3_CKE	PIN_AJ21	Clock Enable pin for DDR3	SSTL-15 Class I
DDR3_CK_n	PIN_AA15	Clock for DDR3	DIFFERENTIAL 1.5-V SSTL CLASS I
DDR3_CK_p	PIN_AA14	Clock p for DDR3	Differential 1.5-V SSTL Class I
DDR3_CS_n	PIN_AB15	DDR3 Chip Select	SSTL-15 Class I
DDR3_DM[0]	PIN_AH17	DDR3 Data Mask[0]	SSTL-15 Class I
DDR3_DM[1]	PIN_AG23	DDR3 Data Mask[1]	SSTL-15 Class I
DDR3_DM[2]	PIN_AK23	DDR3 Data Mask[2]	SSTL-15 Class I



DDR3_DM[3]	PIN_AJ27	DDR3 Data Mask[3]	SSTL-15 Class I
DDR3_DQ[0]	PIN_AF18	DDR3 Data[0]	SSTL-15 Class I
DDR3_DQ[1]	PIN_AE17	DDR3 Data[1]	SSTL-15 Class I
DDR3_DQ[2]	PIN_AG16	DDR3 Data[2]	SSTL-15 Class I
DDR3_DQ[3]	PIN_AF16	DDR3 Data[3]	SSTL-15 Class I
DDR3_DQ[4]	PIN_AH20	DDR3 Data[4]	SSTL-15 Class I
DDR3_DQ[5]	PIN_AG21	DDR3 Data[5]	SSTL-15 Class I
DDR3_DQ[6]	PIN_AJ16	DDR3 Data[6]	SSTL-15 Class I
DDR3_DQ[7]	PIN_AH18	DDR3 Data[7]	SSTL-15 Class I
DDR3_DQ[8]	PIN_AK18	DDR3 Data[8]	SSTL-15 Class I
DDR3_DQ[9]	PIN_AJ17	DDR3 Data[9]	SSTL-15 Class I
DDR3_DQ[10]	PIN_AG18	DDR3 Data[10]	SSTL-15 Class I
DDR3_DQ[11]	PIN_AK19	DDR3 Data[11]	SSTL-15 Class I
DDR3_DQ[12]	PIN_AG20	DDR3 Data[12]	SSTL-15 Class I
DDR3_DQ[13]	PIN_AF19	DDR3 Data[13]	SSTL-15 Class I
DDR3_DQ[14]	PIN_AJ20	DDR3 Data[14]	SSTL-15 Class I
DDR3_DQ[15]	PIN_AH24	DDR3 Data[15]	SSTL-15 Class I
DDR3_DQ[16]	PIN_AE19	DDR3 Data[16]	SSTL-15 Class I
DDR3_DQ[17]	PIN_AE18	DDR3 Data[17]	SSTL-15 Class I
DDR3_DQ[18]	PIN_AG22	DDR3 Data[18]	SSTL-15 Class I
DDR3_DQ[19]	PIN_AK22	DDR3 Data[19]	SSTL-15 Class I
DDR3_DQ[20]	PIN_AF21	DDR3 Data[20]	SSTL-15 Class I
DDR3_DQ[21]	PIN_AF20	DDR3 Data[21]	SSTL-15 Class I
DDR3_DQ[22]	PIN_AH23	DDR3 Data[22]	SSTL-15 Class I
DDR3_DQ[23]	PIN_AK24	DDR3 Data[23]	SSTL-15 Class I
DDR3_DQ[24]	PIN_AF24	DDR3 Data[24]	SSTL-15 Class I
DDR3_DQ[25]	PIN_AF23	DDR3 Data[25]	SSTL-15 Class I
DDR3_DQ[26]	PIN_AJ24	DDR3 Data[26]	SSTL-15 Class I
DDR3_DQ[27]	PIN_AK26	DDR3 Data[27]	SSTL-15 Class I
DDR3_DQ[28]	PIN_AE23	DDR3 Data[28]	SSTL-15 Class I
DDR3_DQ[29]	PIN_AE22	DDR3 Data[29]	SSTL-15 Class I
DDR3_DQ[30]	PIN_AG25	DDR3 Data[30]	SSTL-15 Class I
DDR3_DQ[31]	PIN_AK27	DDR3 Data[31]	SSTL-15 Class I
DDR3_DQS_n[0]	PIN_W16	DDR3 Data Strobe n[0]	Differential 1.5-V SSTL Class I
DDR3_DQS_n[1]	PIN_W17	DDR3 Data Strobe n[1]	Differential 1.5-V SSTL Class I
DDR3_DQS_n[2]	PIN_AA18	DDR3 Data Strobe n[2]	Differential 1.5-V SSTL Class I
DDR3_DQS_n[3]	PIN_AD19	DDR3 Data Strobe n[3]	Differential 1.5-V SSTL Class I
DDR3_DQS_p[0]	PIN_V16	DDR3 Data Strobe p[0]	Differential 1.5-V SSTL Class I
DDR3_DQS_p[1]	PIN_V17	DDR3 Data Strobe p[1]	Differential 1.5-V SSTL Class I
DDR3_DQS_p[2]	PIN_Y17	DDR3 Data Strobe p[2]	Differential 1.5-V SSTL

DDR3_DQS_p[3]	PIN_AC20	DDR3 Data Strobe p[3]	Class I
DDR3_ODT	PIN_AE16	DDR3 On-die Termination	Differential 1.5-V SSTL Class I
DDR3_RAS_n	PIN_AH8	DDR3 Row Address Strobe	SSTL-15 Class I
DDR3_RESET_n	PIN_AK21	DDR3 Reset	SSTL-15 Class I
DDR3_WE_n	PIN_AJ6	DDR3 Write Enable	SSTL-15 Class I
DDR3_RZQ	PIN_AG17	External reference ball for output drive calibration	1.5V

3.6.7 Temperature Sensor

The board contains a temperature sensor (Analog Devices ADT7301) to monitor the ambient temperature. It is a band gap temperature sensor with a 13-bit ADC to monitor and digitize the temperature reading to a resolution of 0.03125°C. The interface between sensor and FPGA is SPI serial interface. Detailed information for using the sensor is available in its datasheet, which can be found on the manufacturer's website, or in the Datasheets\TEMP_Sensor folder on the SoCKit System CD. **Figure 3-21** shows the connections between temperature sensor and Cyclone V SoC FPGA. **Table 3-20** gives the all the pin assignments of the sensor.

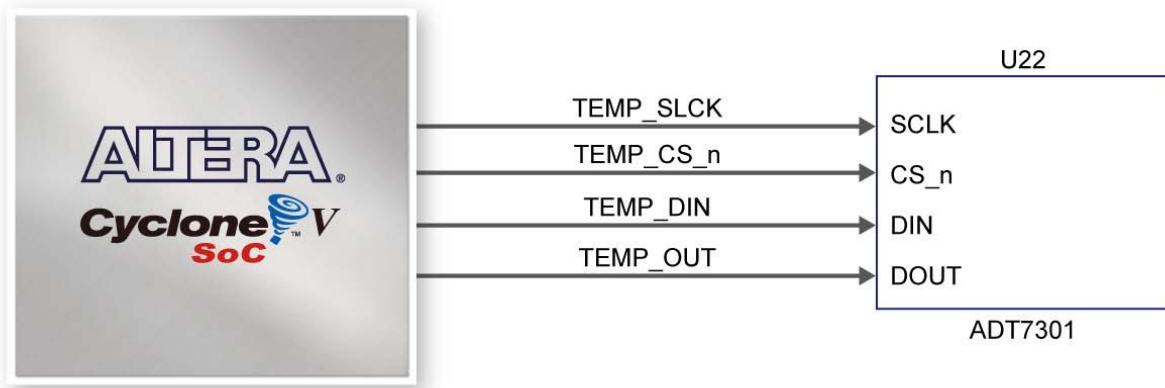


Figure 3-21 Connections between FPGA and Temperature Sensor

Table 3-20 Pin Assignments for Temperature Sensor

Signal Name	FPGA Pin No.	Description	I/O Standard
TEMP_CS_n	PIN_AF8	Temp Sensor Chip Select Input.	3.3V
TEMP_DIN	PIN_AG7	Temp Sensor Serial Data Input	3.3V
TEMP_DOUT	PIN_AG1	Temp Sensor Serial Data Output	3.3V
TEMP_SCLK	PIN_AF9	Temp Sensor Serial Clock Input	3.3V

3.7 Interface on Hard Processor System (HPS)

This section introduces the interfaces connected to the HPS section of the FPGA. Users can access these interfaces via the HPS processor.

3.7.1 User Push-buttons, Switches and LED on HPS

Like the FPGA, the HPS also features its own set of switches, buttons, LEDs, and other user interfaces. Users can control these interfaces for observing HPS status and debugging.

Table 3-21 gives the all the pin assignments of all the user interfaces.

Table 3-21 Pin Assignments for LEDs, Switches and Buttons

Signal Name	HPS GPIO	Register/bit	Function
HPS_KEY[0]	GPIO8	GPIO2[21]	Input only
HPS_KEY[1]	GPIO9	GPIO2[22]	Input only
HPS_KEY[2]	GPIO10	GPIO2[23]	Input only
HPS_KEY[3]	GPIO11	GPIO2[24]	Input only
HPS_SW[0]	GPIO7	GPIO2[20]	Input only
HPS_SW[1]	GPIO6	GPIO2[19]	Input only
HPS_SW[2]	GPIO5	GPIO2[18]	Input only
HPS_SW[3]	GPIO4	GPIO2[17]	Input only
HPS_LED[0]	GPIO54	GPIO1[25]	I/O
HPS_LED[1]	GPIO55	GPIO1[26]	I/O
HPS_LED[2]	GPIO56	GPIO1[27]	I/O
HPS_LED[3]	GPIO57	GPIO1[28]	I/O

3.7.2 Gigabit Ethernet

The board provides Ethernet support via an external Micrel KSZ9021RN PHY chip and HPS Ethernet MAC function. The KSZ9021RN chip with integrated 10/100/1000 Mbps Gigabit Ethernet transceiver support RGMII MAC interfaces. **Figure 3-22** shows the connection setup between the Gigabit Ethernet PHY and Cyclone V SoC FPGA.

The associated pin assignments are listed in **Table 3-22**. For detailed information on how to use the KSZ9021RN refers to its datasheet and application notes, which are available on the manufacturer's website.

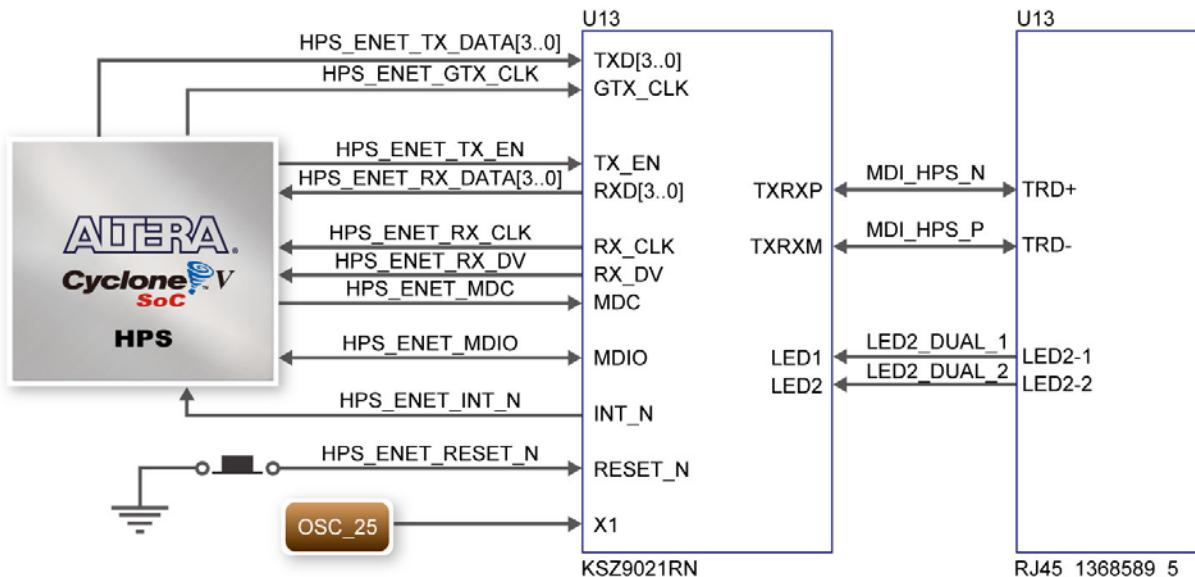


Figure 3-22 Connections between Cyclone V SoC FPGA and Ethernet

Table 3-22 Pin Assignments for Ethernet PHY

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_ENET_TX_EN	PIN_A20	GMII and MII transmit enable	3.3V
HPS_ENET_TX_DATA[0]	PIN_F20	MII transmit data[0]	3.3V
HPS_ENET_TX_DATA[1]	PIN_J19	MII transmit data[1]	3.3V
HPS_ENET_TX_DATA[2]	PIN_F21	MII transmit data[2]	3.3V
HPS_ENET_TX_DATA[3]	PIN_F19	MII transmit data[3]	3.3V
HPS_ENET_RX_DV	PIN_K17	GMII and MII receive data valid	3.3V
HPS_ENET_RX_DATA[0]	PIN_A21	GMII and MII receive data[0]	3.3V
HPS_ENET_RX_DATA[1]	PIN_B20	GMII and MII receive data[1]	3.3V
HPS_ENET_RX_DATA[2]	PIN_B18	GMII and MII receive data[2]	3.3V
HPS_ENET_RX_DATA[3]	PIN_D21	GMII and MII receive data[3]	3.3V
HPS_ENET_RX_CLK	PIN_G20	GMII and MII receive clock	3.3V
HPS_ENET_RESET_n	PIN_E18	Hardware Reset Signal	3.3V
HPS_ENET_MDIO	PIN_E21	Management Data	3.3V
HPS_ENET_MDC	PIN_B21	Management Data Clock Reference	3.3V
HPS_ENET_INT_n	PIN_C19	Interrupt Open Drain Output	3.3V
HPS_ENET_GTX_CLK	PIN_H19	GMII Transmit Clock	3.3V

Additionally, the Ethernet PHY (KSZ9021RNI) LED status has been set to tri-color dual LED mode. The LED control signals are connected to LEDs (orange and green) on the RJ45 connector. States and definitions can be found in **Table 3-23**, which can display the current status of the Ethernet. For example once the green LED lights, the board has been connected to Giga bit Ethernet.

Table 3-23 Tri-Color Dual LED Mode-Pin Definition

LED (State)		LED (Definition)		Link /Activity
LED2	LED1	LED2	LED1	
H	H	OFF	OFF	Link off
L	H	ON	OFF	1000 Link / No Activity
Toggle	H	Blinking	OFF	1000 Link / Activity (RX, TX)
H	L	OFF	ON	100 Link / No Activity
H	Toggle	OFF	Blinking	100 Link / Activity (RX, TX)
L	L	ON	ON	10 Link/ No Activity
Toggle	Toggle	Blinking	Blinking	10 Link / Activity (RX, TX)

3.7.3 UART

The board has one UART interface connected for communication with the HPS. This interface wouldn't support HW flow control signals. The physical interface is done using UART-USB onboard bridge from an FT232R chip and connects to the host using a Micro-USB (B) connector. For detailed information on how to use the transceiver, please refer to the datasheet, which is available on the manufacturer's website, or in the Datasheets\FT232 folder on the SoCKit System CD. **Figure 3-23** shows the related schematics, and **Table 3-24** lists the pin assignments of HPS in Cyclone V SoC FPGA.

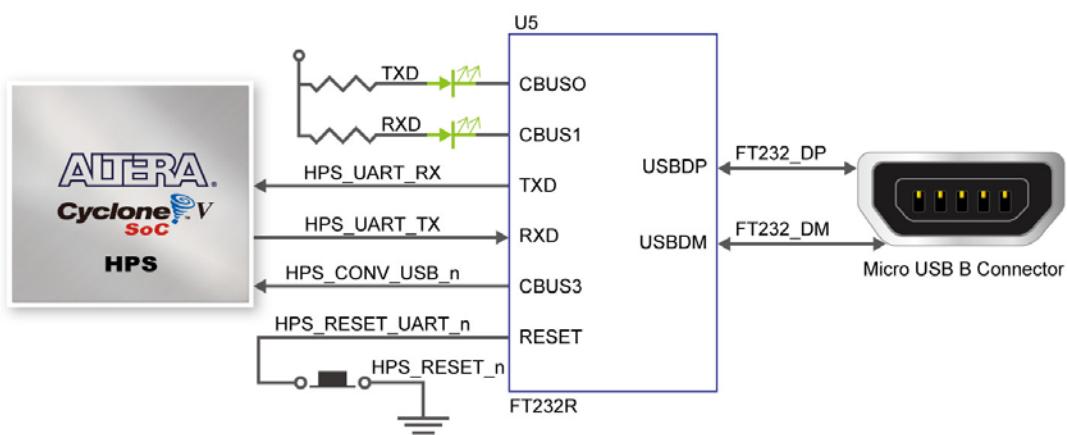


Figure 3-23 Connections between the Cyclone V SoC FPGA and FT232R Chip



Table 3-24 UART Interface I/O

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_UART_RX	PIN_B25	HPS UART Receiver	3.3V
HPS_UART_TX	PIN_C25	HPS UART Transmitter	3.3V
HPS_CONV_USB_n	PIN_B15	Reserve	3.3V

3.7.4 DDR3 Memory on HPS

The DDR3 devices that are connected to the HPS are the exact same devices connected to the FPGA in capacity (1GB) and data-width (32-bit), comprised of two x16 devices with a single address/command bus. This interface connects to dedicated Hard Memory Controller for HPS I/O banks and the target speed is 400 MHz. **Table 3-25** lists DDR3 pin assignments, I/O standards and descriptions with Cyclone V SoC FPGA.

Table 3-25 Pin Assignments for DDR3 Memory

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_DDR3_A[0]	PIN_F26	HPS DDR3 Address[0]	SSTL-15 Class I
HPS_DDR3_A[1]	PIN_G30	HPS DDR3 Address[1]	SSTL-15 Class I
HPS_DDR3_A[2]	PIN_F28	HPS DDR3 Address[2]	SSTL-15 Class I
HPS_DDR3_A[3]	PIN_F30	HPS DDR3 Address[3]	SSTL-15 Class I
HPS_DDR3_A[4]	PIN_J25	HPS DDR3 Address[4]	SSTL-15 Class I
HPS_DDR3_A[5]	PIN_J27	HPS DDR3 Address[5]	SSTL-15 Class I
HPS_DDR3_A[6]	PIN_F29	HPS DDR3 Address[6]	SSTL-15 Class I
HPS_DDR3_A[7]	PIN_E28	HPS DDR3 Address[7]	SSTL-15 Class I
HPS_DDR3_A[8]	PIN_H27	HPS DDR3 Address[8]	SSTL-15 Class I
HPS_DDR3_A[9]	PIN_G26	HPS DDR3 Address[9]	SSTL-15 Class I
HPS_DDR3_A[10]	PIN_D29	HPS DDR3 Address[10]	SSTL-15 Class I
HPS_DDR3_A[11]	PIN_C30	HPS DDR3 Address[11]	SSTL-15 Class I
HPS_DDR3_A[12]	PIN_B30	HPS DDR3 Address[12]	SSTL-15 Class I
HPS_DDR3_A[13]	PIN_C29	HPS DDR3 Address[13]	SSTL-15 Class I
HPS_DDR3_A[14]	PIN_H25	HPS DDR3 Address[14]	SSTL-15 Class I
HPS_DDR3_BA[0]	PIN_E29	HPS DDR3 Bank Address[0]	SSTL-15 Class I
HPS_DDR3_BA[1]	PIN_J24	HPS DDR3 Bank Address[1]	SSTL-15 Class I
HPS_DDR3_BA[2]	PIN_J23	HPS DDR3 Bank Address[2]	SSTL-15 Class I
HPS_DDR3_CAS_n	PIN_E27	DDR3 Column Address Strobe	SSTL-15 Class I
HPS_DDR3_CKE	PIN_L29	HPS DDR3 Clock Enable	SSTL-15 Class I
HPS_DDR3_CK_n	PIN_L23	HPS DDR3 Clock	Differential 1.5-V SSTL Class I
HPS_DDR3_CK_p	PIN_M23	HPS DDR3 Clock p	Differential 1.5-V SSTL Class I
HPS_DDR3_CS_n	PIN_H24	HPS DDR3 Chip Select	SSTL-15 Class I
HPS_DDR3_DM[0]	PIN_K28	HPS DDR3 Data Mask[0]	SSTL-15 Class I
HPS_DDR3_DM[1]	PIN_M28	HPS DDR3 Data Mask[1]	SSTL-15 Class I
HPS_DDR3_DM[2]	PIN_R28	HPS DDR3 Data Mask[2]	SSTL-15 Class I
HPS_DDR3_DM[3]	PIN_W30	HPS DDR3 Data Mask[3]	SSTL-15 Class I



HPS_DDR3_DQ[0]	PIN_K23	HPS DDR3 Data[0]	SSTL-15 Class I
HPS_DDR3_DQ[1]	PIN_K22	HPS DDR3 Data[1]	SSTL-15 Class I
HPS_DDR3_DQ[2]	PIN_H30	HPS DDR3 Data[2]	SSTL-15 Class I
HPS_DDR3_DQ[3]	PIN_G28	HPS DDR3 Data[3]	SSTL-15 Class I
HPS_DDR3_DQ[4]	PIN_L25	HPS DDR3 Data[4]	SSTL-15 Class I
HPS_DDR3_DQ[5]	PIN_L24	HPS DDR3 Data[5]	SSTL-15 Class I
HPS_DDR3_DQ[6]	PIN_J30	HPS DDR3 Data[6]	SSTL-15 Class I
HPS_DDR3_DQ[7]	PIN_J29	HPS DDR3 Data[7]	SSTL-15 Class I
HPS_DDR3_DQ[8]	PIN_K26	HPS DDR3 Data[8]	SSTL-15 Class I
HPS_DDR3_DQ[9]	PIN_L26	HPS DDR3 Data[9]	SSTL-15 Class I
HPS_DDR3_DQ[10]	PIN_K29	HPS DDR3 Data[10]	SSTL-15 Class I
HPS_DDR3_DQ[11]	PIN_K27	HPS DDR3 Data[11]	SSTL-15 Class I
HPS_DDR3_DQ[12]	PIN_M26	HPS DDR3 Data[12]	SSTL-15 Class I
HPS_DDR3_DQ[13]	PIN_M27	HPS DDR3 Data[13]	SSTL-15 Class I
HPS_DDR3_DQ[14]	PIN_L28	HPS DDR3 Data[14]	SSTL-15 Class I
HPS_DDR3_DQ[15]	PIN_M30	HPS DDR3 Data[15]	SSTL-15 Class I
HPS_DDR3_DQ[16]	PIN_U26	HPS DDR3 Data[16]	SSTL-15 Class I
HPS_DDR3_DQ[17]	PIN_T26	HPS DDR3 Data[17]	SSTL-15 Class I
HPS_DDR3_DQ[18]	PIN_N29	HPS DDR3 Data[18]	SSTL-15 Class I
HPS_DDR3_DQ[19]	PIN_N28	HPS DDR3 Data[19]	SSTL-15 Class I
HPS_DDR3_DQ[20]	PIN_P26	HPS DDR3 Data[20]	SSTL-15 Class I
HPS_DDR3_DQ[21]	PIN_P27	HPS DDR3 Data[21]	SSTL-15 Class I
HPS_DDR3_DQ[22]	PIN_N27	HPS DDR3 Data[22]	SSTL-15 Class I
HPS_DDR3_DQ[23]	PIN_R29	HPS DDR3 Data[23]	SSTL-15 Class I
HPS_DDR3_DQ[24]	PIN_P24	HPS DDR3 Data[24]	SSTL-15 Class I
HPS_DDR3_DQ[25]	PIN_P25	HPS DDR3 Data[25]	SSTL-15 Class I
HPS_DDR3_DQ[26]	PIN_T29	HPS DDR3 Data[26]	SSTL-15 Class I
HPS_DDR3_DQ[27]	PIN_T28	HPS DDR3 Data[27]	SSTL-15 Class I
HPS_DDR3_DQ[28]	PIN_R27	HPS DDR3 Data[28]	SSTL-15 Class I
HPS_DDR3_DQ[29]	PIN_R26	HPS DDR3 Data[29]	SSTL-15 Class I
HPS_DDR3_DQ[30]	PIN_V30	HPS DDR3 Data[30]	SSTL-15 Class I
HPS_DDR3_DQ[31]	PIN_W29	HPS DDR3 Data[31]	SSTL-15 Class I
HPS_DDR3_DQS_n[0]	PIN_M19	HPS DDR3 Data Strobe n[0]	Differential 1.5-V SSTL Class I
HPS_DDR3_DQS_n[1]	PIN_N24	HPS DDR3 Data Strobe n[1]	Differential 1.5-V SSTL Class I
HPS_DDR3_DQS_n[2]	PIN_R18	HPS DDR3 Data Strobe n[2]	Differential 1.5-V SSTL Class I
HPS_DDR3_DQS_n[3]	PIN_R21	HPS DDR3 Data Strobe n[3]	Differential 1.5-V SSTL Class I
HPS_DDR3_DQS_p[0]	PIN_N18	HPS DDR3 Data Strobe p[0]	Differential 1.5-V SSTL Class I
HPS_DDR3_DQS_p[1]	PIN_N25	HPS DDR3 Data Strobe p[1]	Differential 1.5-V SSTL Class I
HPS_DDR3_DQS_p[2]	PIN_R19	HPS DDR3 Data Strobe p[2]	Differential 1.5-V SSTL Class I
HPS_DDR3_DQS_p[3]	PIN_R22	HPS DDR3 Data Strobe p[3]	Differential 1.5-V SSTL Class I
HPS_DDR3_ODT	PIN_H28	HPS DDR3 On-die Termination	SSTL-15 Class I
HPS_DDR3_RAS_n	PIN_D30	DDR3 Row Address Strobe	SSTL-15 Class I
HPS_DDR3_RESET_n	PIN_P30	HPS DDR3 Reset	SSTL-15 Class I
HPS_DDR3_WE_n	PIN_C28	HPS DDR3 Write Enable	SSTL-15 Class I
HPS_DDR3_RZQ	PIN_D27	External reference ball for output drive calibration	1.5 V

3.7.5 QSPI Flash

The board supports a 1G-bit serial NOR flash device for non-volatile storage of HPS boot code, user data and program. The device is connected to HPS dedicated interface. It may contain secondary boot code.

This device has a 4-bit data interface and uses 3.3V CMOS signaling standard. Connections between Cyclone V SoC FPGA and Flash are shown in [Figure 3-24](#).

To program the QSPI flash, the **HPS Flash Programmer** is provided both as part of the Altera Quartus II suite and as part of the free Altera Quartus II Programmer. The HPS Flash Programmer sends file contents over an Altera download cable, such as the USB Blaster II, to the HPS, and instructs the HPS to write the data to the flash memory.

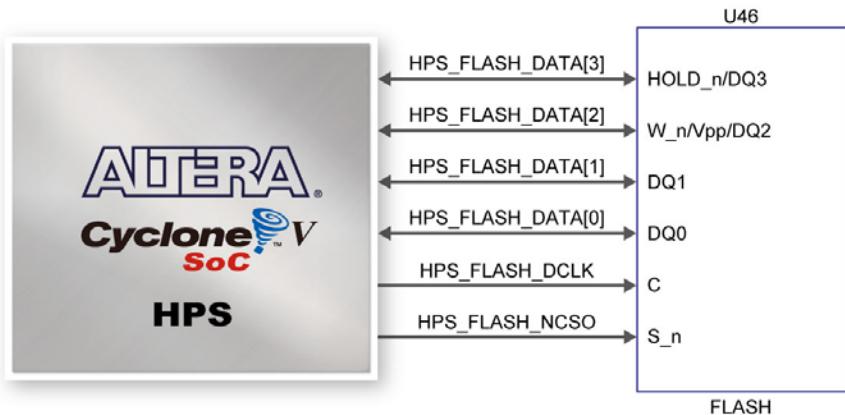


Figure 3-24 Connections Between Cyclone V SoC FPGA and QSPI Flash

Table 3-26 below summarizes the pins on the flash device. Signal names are from the device datasheet and directions are relative to the Cyclone V SoC FPGA.

Table 3-26 QSPI Flash Interface I/O

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_FLASH_DATA[0]	PIN_C20	HPS FLASH Data[0]	3.3V
HPS_FLASH_DATA[1]	PIN_H18	HPS FLASH Data[1]	3.3V
HPS_FLASH_DATA[2]	PIN_A19	HPS FLASH Data[2]	3.3V
HPS_FLASH_DATA[3]	PIN_E19	HPS FLASH Data[3]	3.3V
HPS_FLASH_DCLK	PIN_D19	HPS FLASH Data Clock	3.3V
HPS_FLASH_NCSO	PIN_A18	HPS FLASH Chip Enable	3.3V

3.7.6 Micro SD

The board supports Micro SD card interface using x4 data lines. And it may contain secondary boot code for HPS. **Figure 3-25** shows the related signals.

Finally, **Table 3-27** lists all the associated pins for interfacing HPS respectively.

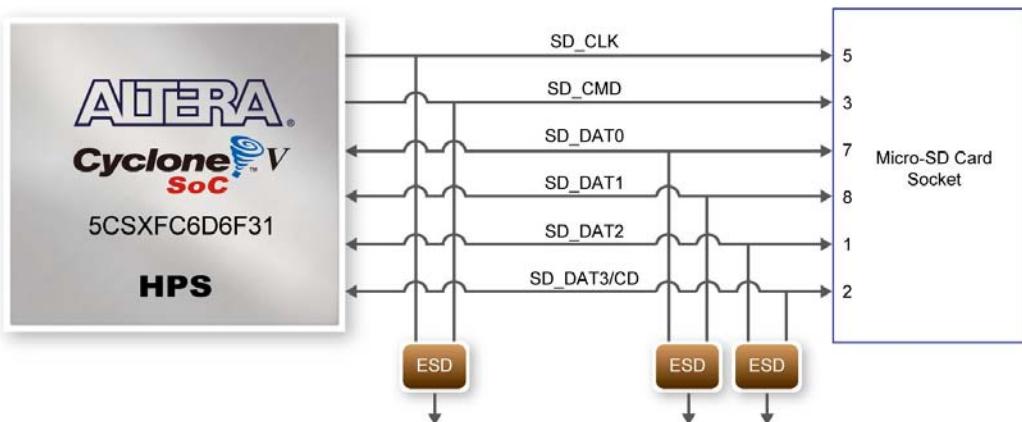


Figure 3-25 Connections between Cyclone V SoC FPGA and SD Card Socket

Table 3-27 SD Card Socket Pin Assignments

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_SD_CLK	PIN_A16	HPS SD Clock	3.3V
HPS_SD_CMD	PIN_F18	HPS SD Command Line	3.3V
HPS_SD_DATA[0]	PIN_G18	HPS SD Data[0]	3.3V
HPS_SD_DATA[1]	PIN_C17	HPS SD Data[1]	3.3V
HPS_SD_DATA[2]	PIN_D17	HPS SD Data[2]	3.3V
HPS_SD_DATA[3]	PIN_B16	HPS SD Data[3]	3.3V

3.7.7 USB 2.0 OTG PHY

The board provides USB interfaces using the SMSC USB3300 controller. A SMSC USB3300 device in a 32-pin QFN package device is used to interface to a single Type AB Micro-USB connector. This device supports UTMI+ Low Pin Interface (ULPI) to communicate to USB 2.0 controller in HPS. As defined by OTG mode, the PHY can operate in Host or Device modes. When operating in Host mode, the interface will supply the power to the device through the Micro-USB interface. **Figure 3-26** shows the schematic diagram of the USB circuitry; the pin assignments for the associated interface are listed in **Table 3-28**.

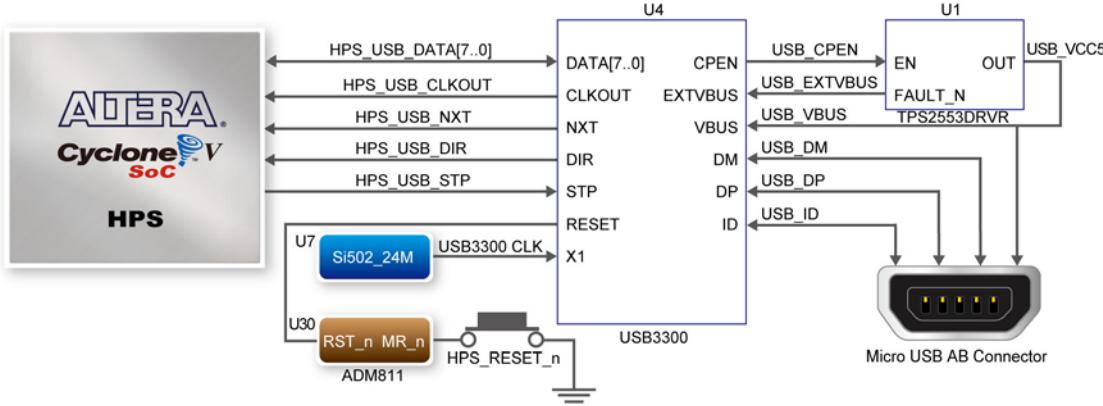


Figure 3-26 Connections between Cyclone V SoC FPGA and USB OTG PHY

Table 3-28 USB OTG PHY Pin Assignments

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_USB_CLKOUT	PIN_N16	60MHz Reference Clock Output	3.3V
HPS_USB_DATA[0]	PIN_E16	HPS USB_DATA[0]	3.3V
HPS_USB_DATA[1]	PIN_G16	HPS USB_DATA[1]	3.3V
HPS_USB_DATA[2]	PIN_D16	HPS USB_DATA[2]	3.3V
HPS_USB_DATA[3]	PIN_D14	HPS USB_DATA[3]	3.3V
HPS_USB_DATA[4]	PIN_A15	HPS USB_DATA[4]	3.3V
HPS_USB_DATA[5]	PIN_C14	HPS USB_DATA[5]	3.3V
HPS_USB_DATA[6]	PIN_D15	HPS USB_DATA[6]	3.3V
HPS_USB_DATA[7]	PIN_M17	HPS USB_DATA[7]	3.3V
HPS_USB_DIR	PIN_E14	Direction of the Data Bus	3.3V
HPS_USB_NXT	PIN_A14	Throttle the Data	3.3V
HPS_USB_RESET_PHY	PIN_G17	HPS USB PHY Reset	3.3V
HPS_USB_STP	PIN_C15	Stop Data Stream on theBus	3.3V

3.7.8 G-Sensor

The board is equipped with a digital accelerometer sensor module. The ADXL345 is a small, thin, ultralow power assumption 3-axis accelerometer with high-resolution measurement. Digitized output is formatted as 16-bit twos complement and can be accessed using I2C interface. Connected to the I2C interface includes two peripherals, the G-sensor and the LTC connector. The I2C address of the G-Sensor device is 0xA6/0xA7. For more detailed information of better using this chip, please refer to its datasheet which is available on manufacturer's website or under the Datasheet folder of the SoCKit System CD. **Figure 3-27** shows the connections between ADXL345 and HPS. The associated pin assignments are listed in **Table 3-29**.

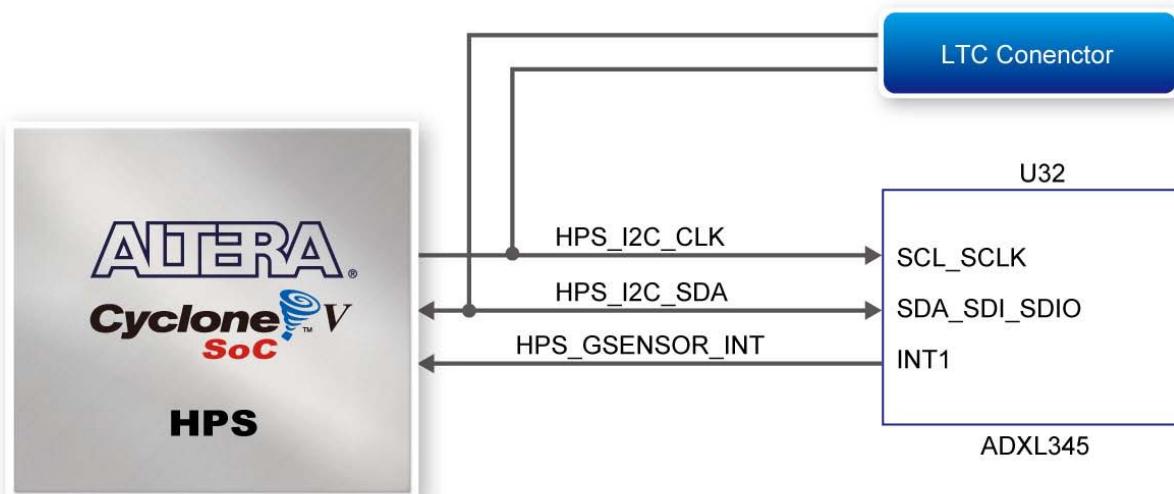


Figure 3-27 Connections between Cyclone V SoC FPGA and G-Sensor

Table 3-29 G-Sensor Pin Assignments

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_GSENSOR_INT	PIN_B22	HPS GSENSOR Interrupt Output	3.3V
HPS_I2C_CLK	PIN_H23	HPS I2C Clock (share bus with LTC)	3.3V
HPS_I2C_SDA	PIN_A25	HPS I2C Data (share bus)	3.3V

3.7.9 128x64 Dots LCD

The board equips an LCD Module with 128x64 dots for display capabilities. The LCD module uses serial peripheral interface to connect with the HPS. To use the LCD module, please refer to the datasheet folder in SoCKit System CD. **Figure 3-28** shows the connections between the HPS and LCD module. The default setting for LCD backlight power is ON by shorting the pins of header JP1. **Table 3-30** lists the pin assignments between LCD module and Cyclone V SoC FPGA.

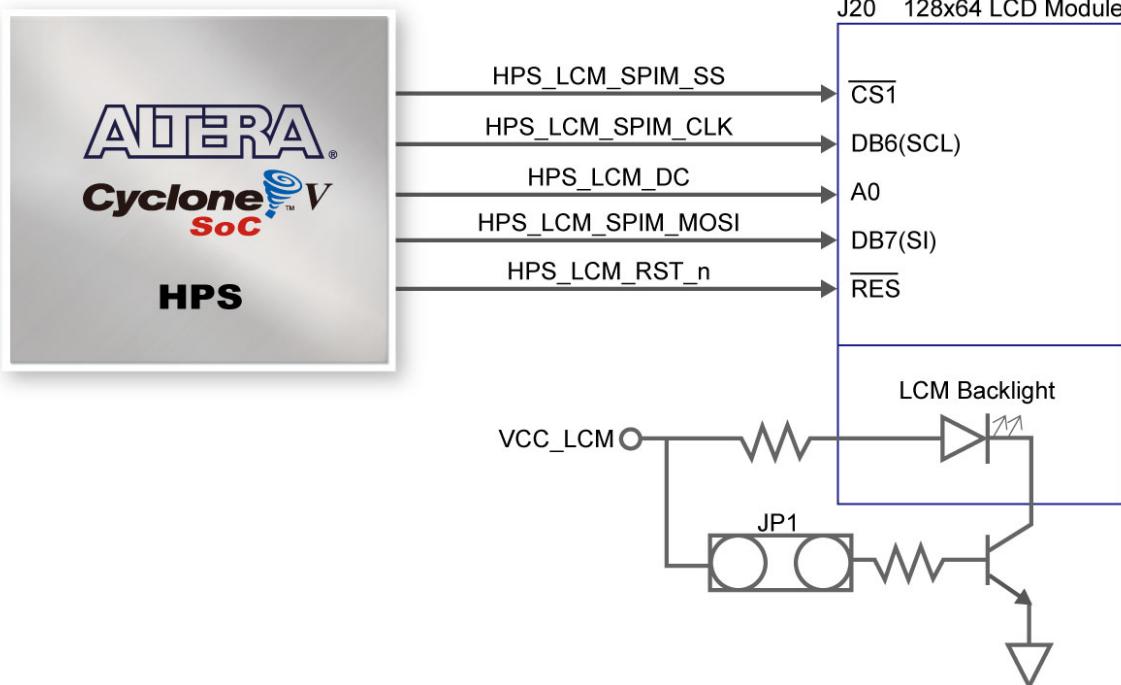


Figure 3-28 Connections between Cyclone V SoC FPGA and LCD Module

Table 3-30 LCD Module Pin Assignments

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_LCM_D_C	PIN_G22	HPS LCM Data bit is Data/Command	3.3V
HPS_LCM_RST_N	PIN_B26	HPS LCM Reset	3.3V
HPS_LCM_SPIM_CLK	PIN_C23	SPI Clock	3.3V
HPS_LCM_SPIM_MOSI	PIN_D22	SPI Master Output /Slave Input	3.3V
HPS_LCM_SPIM_SS	PIN_D24	SPI Slave Select	3.3V

3.7.10 LTC Connector

The board allows connection to interface card from Linear Technology. The interface is implemented using 14-pin header that can be connected to variety of demo boards from Linear Technology. It will be connected to SPI Master and I2C ports of the HPS to allow bidirectional communication with two types of protocols. The 14-pin header will allow for GPIO, SPI and I2C extension for user purposes if the interfaces to Linear Technology board aren't in use. Connections between the LTC connector and the HPS are shown in [Figure 3-29](#), and the functions of the 14 pins is listed in [Table 3-31](#).

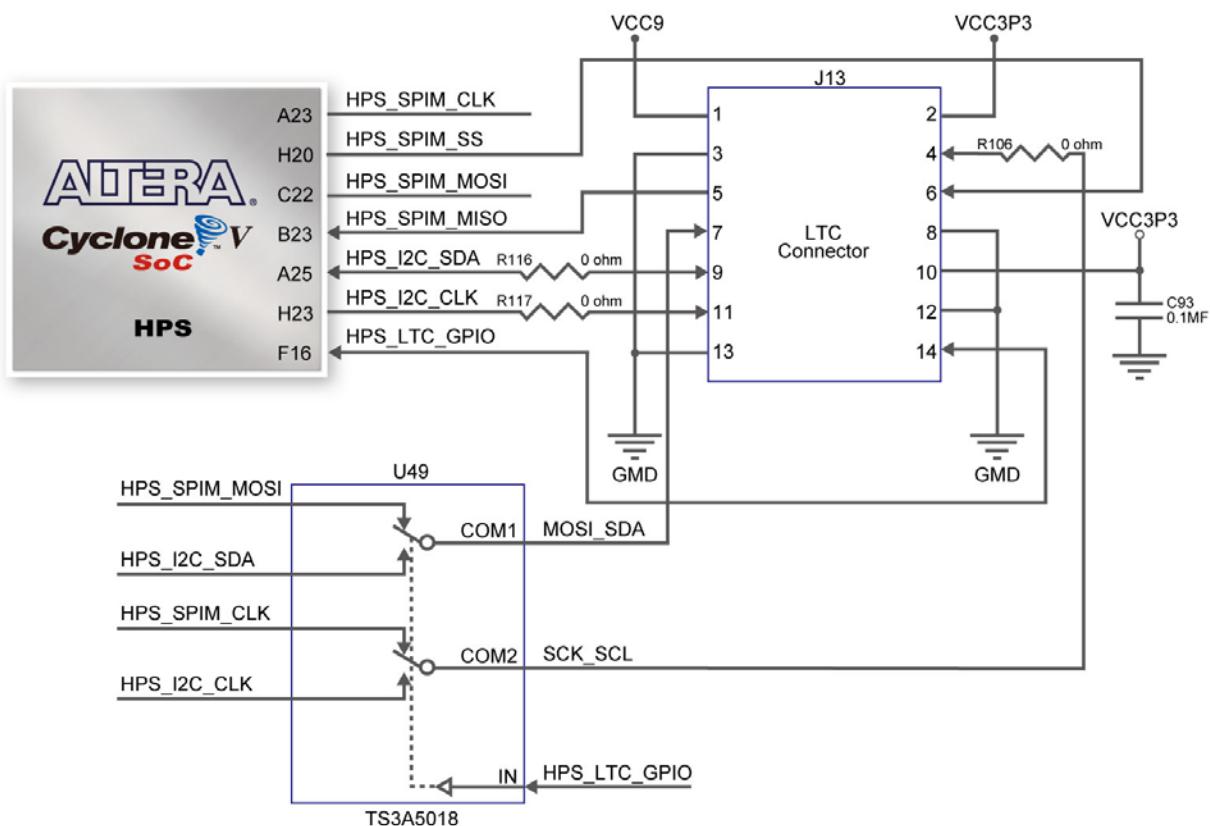


Figure 3-29 Connections between the LTC Connector and HPS

Table 3-31 LTC Connector Pin Assignments

Signal Name	FPGA Pin No.	Description	I/O Standard
HPS_LTC_GPIO	PIN_F16	HPS LTC GPIO	3.3V
HPS_I2C_CLK	PIN_H23	HPS I2C Clock (share bus with G-Sensor)	3.3V
HPS_I2C_SDA	PIN_A25	HPS I2C Data (share bus with G-Sensor)	3.3V
HPS_SPIM_CLK	PIN_A23	SPI Clock	3.3V
HPS_SPIM_MISO	PIN_B23	SPI Master Input/Slave Output	3.3V
HPS_SPIM_MOSI	PIN_C22	SPI Master Output /Slave Input	3.3V
HPS_SPIM_SS	PIN_H20	SPI Slave Select	3.3V



Chapter 4

SoCKit System Builder

This chapter describes how users can create a custom design project on the board by using the SoCKit Software Tool – SoCKit System Builder.

4.1 Introduction

The SoCKit System Builder is a Windows-based software utility, designed to assist users to create a Quartus II project for the board within minutes. The generated Quartus II project files include:

- Quartus II Project File (.qpf)
- Quartus II Setting File (.qsf)
- Top-Level Design File (.v)
- Synopsis Design Constraints file (.sdc)
- Pin Assignment Document (.htm)

By providing the above files, the SoCKit System Builder prevents occurrence of situations that are prone to errors when users manually edit the top-level design file or place pin assignments. The common mistakes that users encounter are the following:

1. Board damage due to wrong pin/bank voltage assignments.
2. Board malfunction caused by wrong device connections or missing pin counts for connected ends.
3. Performance degeneration due to improper pin assignments.

4.2 General Design Flow

This section will introduce the general design flow to build a project for the development board via the SoCKit System Builder. The general design flow is illustrated in [Figure 4-1](#).

Users should launch the SoCKit System Builder and create a new project according to their design requirements. When users complete the settings, the SoCKit System Builder will generate two major files, a top-level design file (.v) and a Quartus II setting file (.qsf).



The top-level design file contains top-level Verilog HDL wrapper for users to add their own design/logic. The Quartus II setting file contains information such as FPGA device type, top-level pin assignment, and the I/O standard for each user-defined I/O pin.

Finally, the Quartus II programmer must be used to download SOF file to the development board using a JTAG interface.

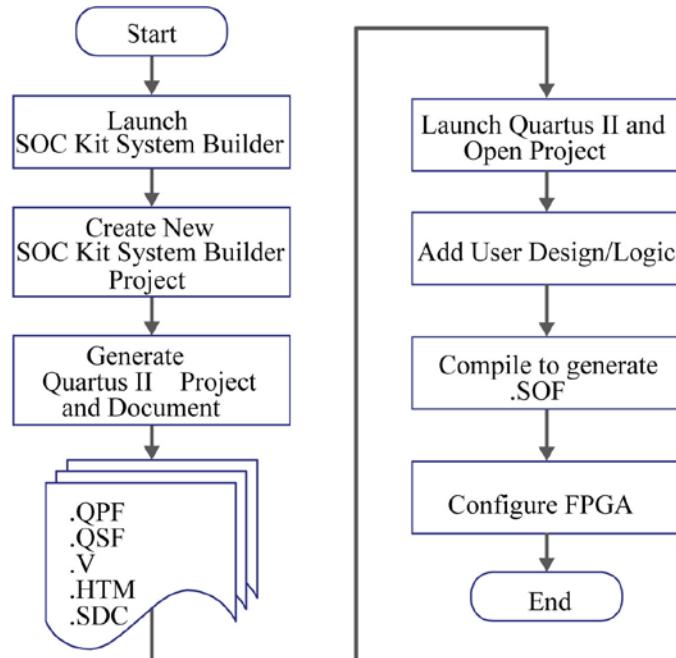


Figure 4-1 The general design flow of building a design

4.3 Using SoCKit System Builder

This section provides the detailed procedures on how the SoCKit System Builder is used.

■ Install and launch the SoCKit System Builder

The SoCKit System Builder is located in the directory:

“*Tools\SOC_Kit_system_builder*” on the SoCKit System CD. Users can copy the whole folder to a host computer without installing the utility. Launch the SoCKit System Builder by executing the **SOC_Kit_SystemBuilder.exe** on the host computer and the GUI window will appear as shown in **Figure 4-2**.

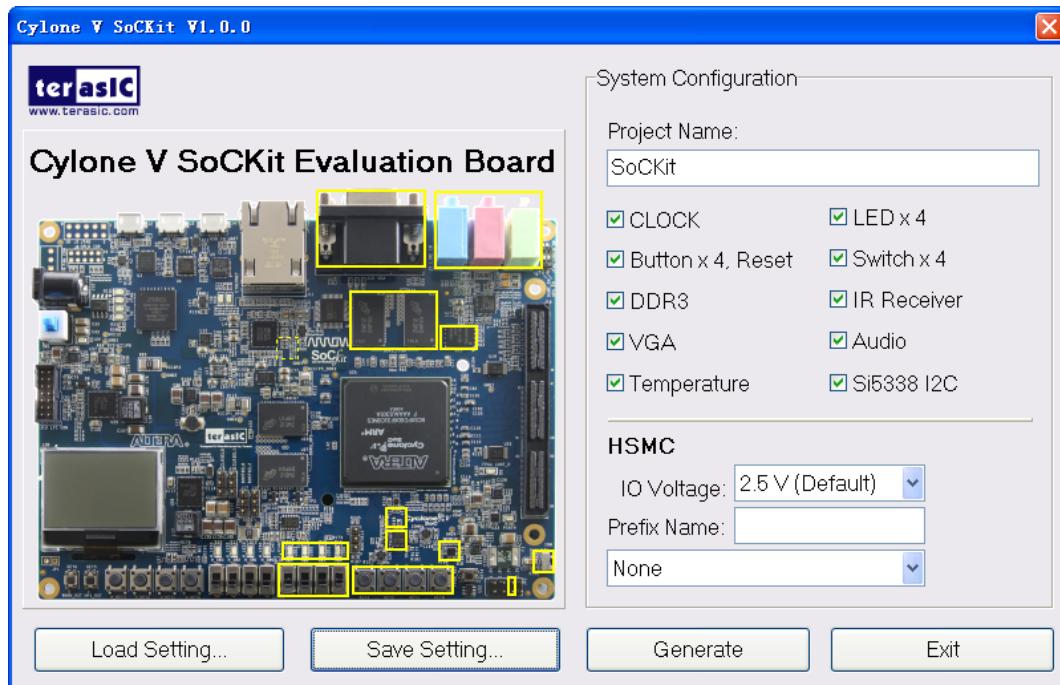


Figure 4-2 The SoCKit System Builder window

■ Input Project Name

Input project name as show in **Figure 4-3**.

Project Name: Type in an appropriate name here, it will automatically be assigned as the name of your top-level design entity.

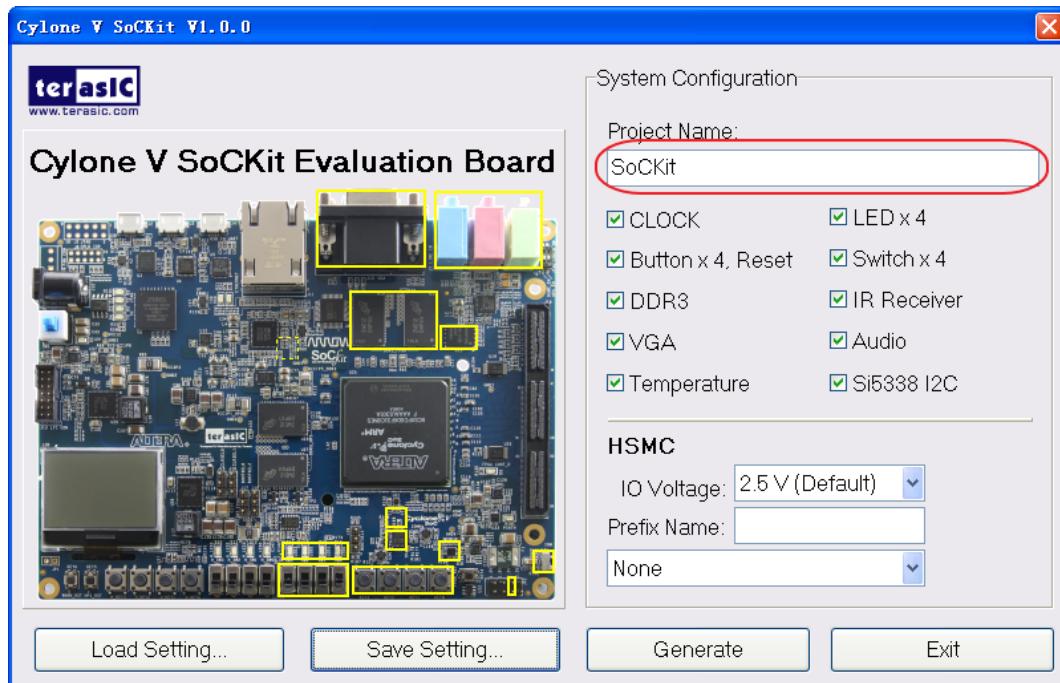


Figure 4-3 Board Type and Project Name

■ System Configuration

Under the System Configuration users are given the flexibility of enabling their choice of included components on the board as shown in **Figure 4-4**. Each component of the board is listed where users can enable or disable a component according to their design by simply marking a check or removing the check in the field provided. If the component is enabled, the SoCKit System Builder will automatically generate the associated pin assignments including the pin name, pin location, pin direction, and I/O standard.

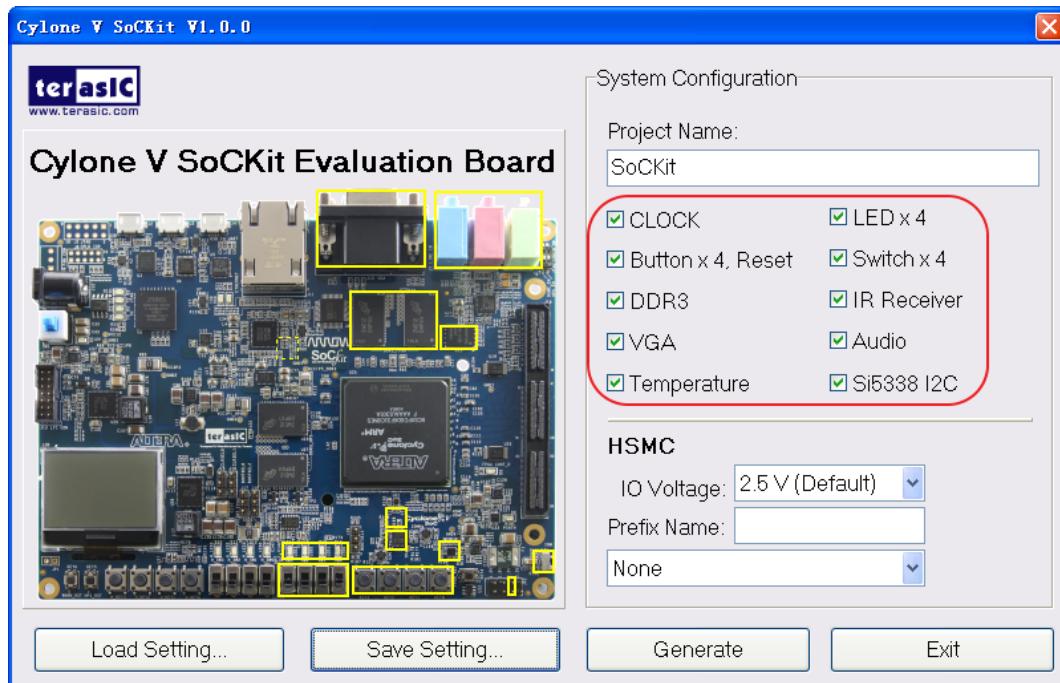


Figure 4-4 System Configuration Group

■ HSMC Expansion

Users can connect HSMC daughter cards onto the HSMC connector located on the development board shown in **Figure 4-5**. Select the daughter card you wish to add to your design under the appropriate HSMC connector to which the daughter card is connected. The System Builder will automatically generate the associated pin assignment including pin name, pin location, pin direction, and I/O standard.

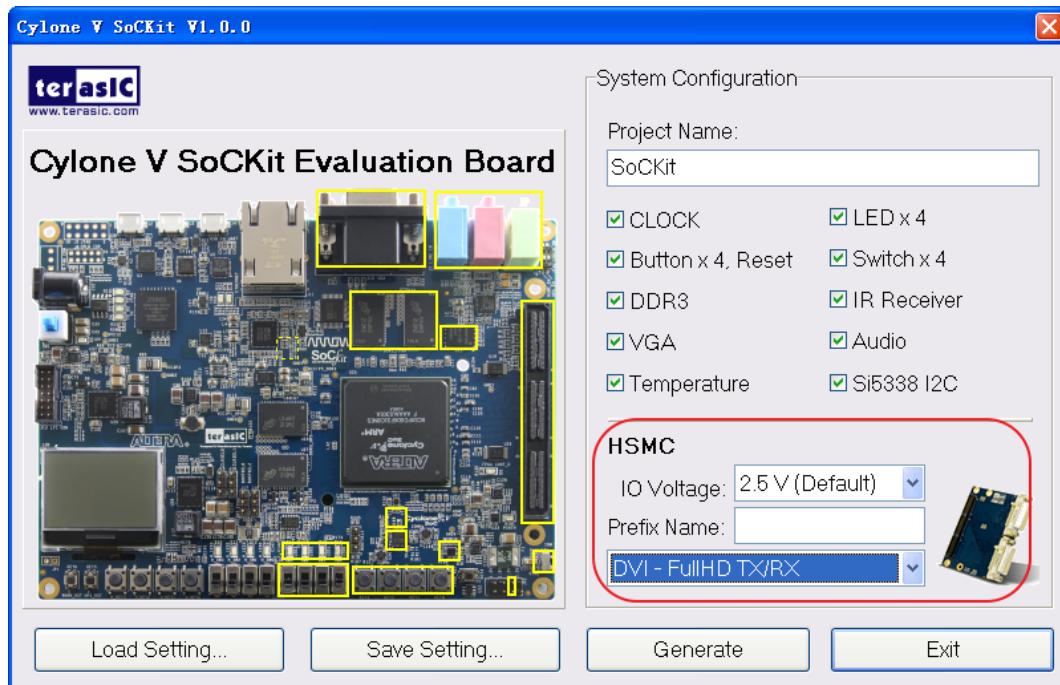


Figure 4-5 HSMC Expansion Group

The “Prefix Name” is an optional feature that denotes the pin name of the daughter card assigned in your design. Users may leave this field empty.

■ Project Setting Management

The SoCKit System Builder also provides functions to restore default setting, loading a setting, and saving users’ board configuration file shown in **Figure 4-6**. Users can save the current board configuration information into a .cfg file and load it to the SoCKit System Builder.

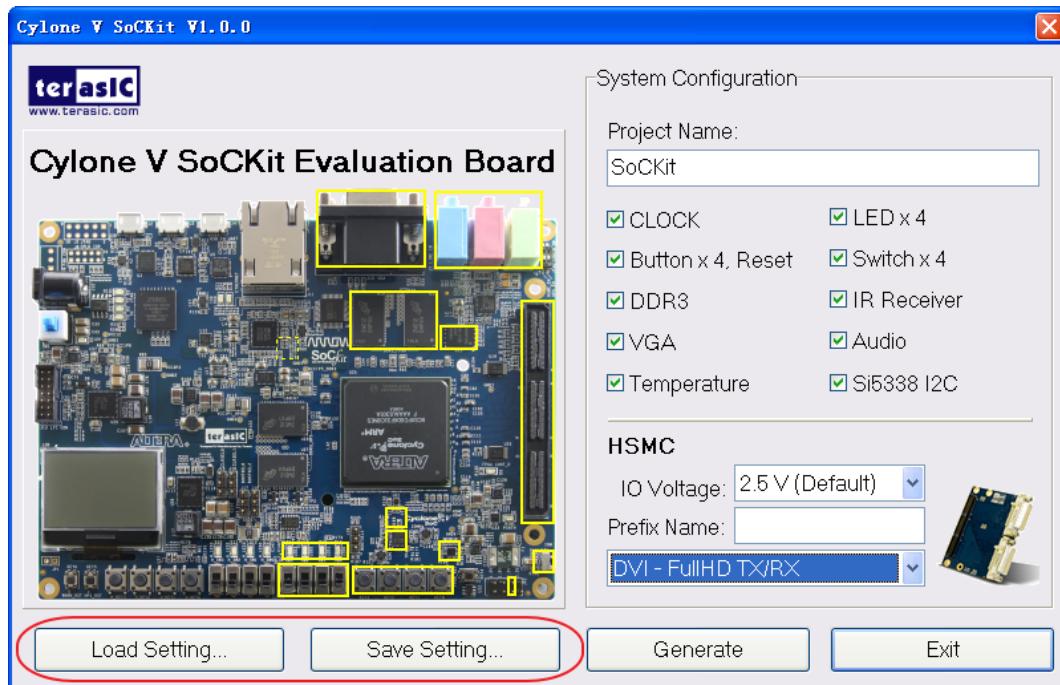


Figure 4-6 Project Settings

■ Project Generation

When users press the *Generate* button, the SoCKit System Builder will generate the corresponding Quartus II files and documents as listed in the **Table 4-1**:

Table 4-1 The files generated by SoCKit System Builder

No.	Filename	Description
1	<Project name>.v	Top level Verilog HDL file for Quartus II
2	<Project name>.qpf	Quartus II Project File
3	<Project name>.qsf	Quartus II Setting File
4	<Project name>.sdc	Synopsis Design Constraints file for Quartus II
5	<Project name>.htm	Pin Assignment Document

Users can use Quartus II software to add custom logic into the project and compile the project to generate the SRAM Object File (.sof).

Chapter 5

Examples For FPGA

This chapter provides a number of examples of advanced circuits implemented by RTL or Qsys on the SoCKit board. These circuits provide demonstrations of the major features which connected to FPGA interface on the board, such as audio, DDR3 and IR receiver. All of the associated files can be found in the *Demonstrations/FPGA* folder on the SoCKit System CD.

■ Installing the Demonstrations

To install the demonstrations on your computer:

Copy the directory *Demonstrations* into a local directory of your choice. It is important to ensure that the path to your local directory contains no spaces – otherwise, the Nios II software will not work. **Note Quartus II v13 is required for all SoCKit demonstrations to support Cyclone V SoC device.**

5.1 Audio Recording and Playing

This demonstration shows how to implement an audio recorder and player using the SoCKit board with the built-in Audio CODEC chip. This demonstration is developed based on Qsys and Eclipse. **Figure 5-1** shows the man-machine interface of this demonstration. Two push-buttons and four slide switches are used for users to configure this audio system: SW0 is used to specify recording source to be Line-in or MIC-In. SW1, SW2, and SW3 are used to specify recording sample rate as 96K, 48K, 44.1K, 32K, or 8K. **Table 5-1** and

Table 5-2 summarize the usage of Slide switches for configuring the audio recorder and player.

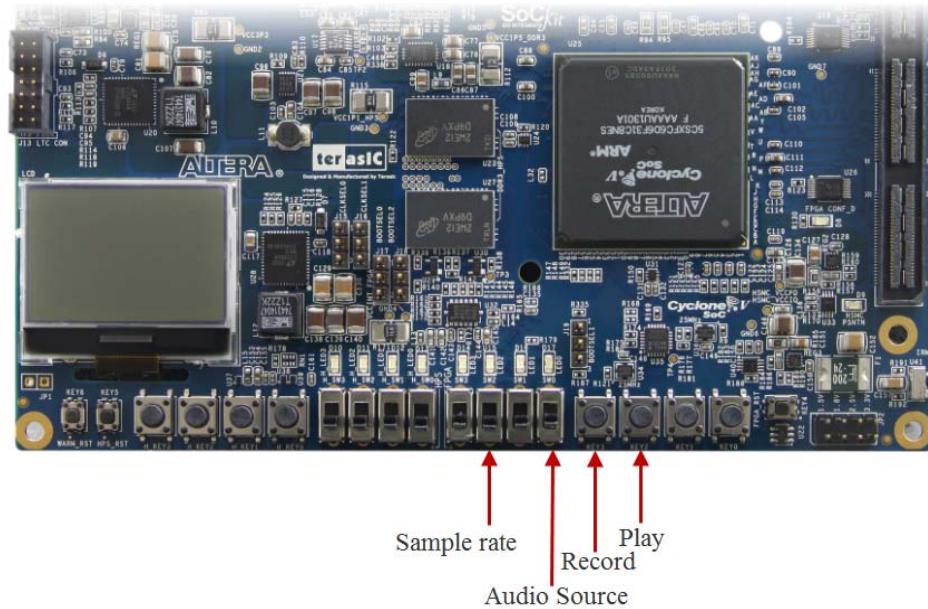


Figure 5-1 Man-Machine Interface of Audio Recorder and Player

Figure 5-2 shows the block diagram of the Audio Recorder and Player design. There are hardware and software parts in the block diagram. The software part stores the Nios II program in the on-chip memory. The software part is built by Eclipse in C programming language. The hardware part is built by Qsys under Quartus II. The hardware part includes all the other blocks. The “AUDIO Controller” is a user-defined Qsys component. It is designed to send audio data to the audio chip or receive audio data from the audio chip.

The audio chip is programmed through I2C protocol which is implemented in C code. The I2C pins from audio chip are connected to Qsys System Interconnect Fabric through PIO controllers. In this example, the audio chip is configured in Master Mode. The audio interface is configured as I2S and 16-bit mode. 18.432MHz clock generated by the PLL is connected to the MCLK/XTI pin of the audio chip through the AUDIO Controller.

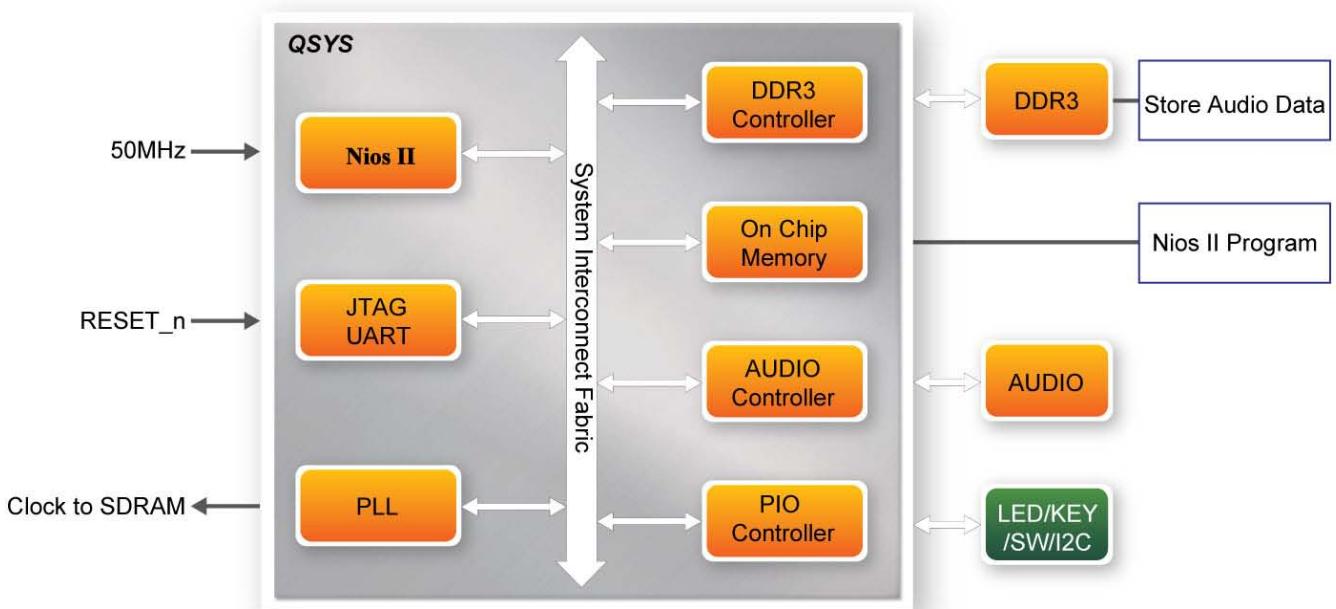


Figure 5-2 Block diagram of the audio recorder and player

■ Demonstration Setup, File Locations, and Instructions

- Hardware Project directory: SoCKit _Audio
- Bit stream used: SoCKit _Audio.sof
- Software Project directory: SoCKit _Audio\software
- Connect an Audio Source to the LINE-IN port of the SoCKit board.
- Connect a Microphone to MIC-IN port on the SoCKit board.
- Connect a speaker or headset to LINE-OUT port on the SoCKit board.
- Load the bit stream into FPGA. (note *1)
- Load the Software Execution File into FPGA. (note *1)
- Configure audio with the Slide switches SW0 as shown in **Table 5-1**.
- Press KEY3 on the SoCKit board to start/stop audio recording (note *2)
- Press KEY2 on the SoCKit board to start/stop audio playing (note *3)

Table 5-1 Slide switches usage for audio source

Slide Switches	0 – DOWN Position	1 – UP Position
SW0	Audio is from MIC	Audio is from LINE-IN

Table 5-2 Slide switch setting for sample rate switching for audio recorder and player

SW3 (0 – DOWN; 1- UP)	SW2 (0 – DOWN; 1-UP)	SW1 (0 – DOWN; 1-UP)	Sample Rate
0	0	0	96K
0	0	1	48K
0	1	0	44.1K
0	1	1	32K
1	0	0	8K
Unlisted combination			96K



Note:

- (1). Execute SoCKit _Audio \demo_batch\ SoCKit _Audio.bat will download .sof and .elf files.
- (2). Recording process will stop if audio buffer is full.
- (3). Playing process will stop if audio data is played completely.

5.2 A Karaoke Machine

This demonstration uses the microphone-in, line-in, and line-out ports on the SOCKIT board to create a Karaoke Machine application. The SSM2603 audio CODEC is configured in the master mode, with which the audio CODEC generates AD/DA serial bit clock (BCK) and the left/right channel clock (LRCK) automatically. As indicated in [Figure 5-3](#), the I2C interface is used to configure the Audio CODEC. The sample rate and gain of the CODEC are set in this manner, and the data input from the line-in port is then mixed with the microphone-in port and the result is sent to the line-out port.

For this demonstration the sample rate is set to 48kHz. Pressing the pushbutton KEY0 reconfigures the gain of the audio CODEC via I2C bus, cycling within ten predefined gain values (volume levels) provided by the device.

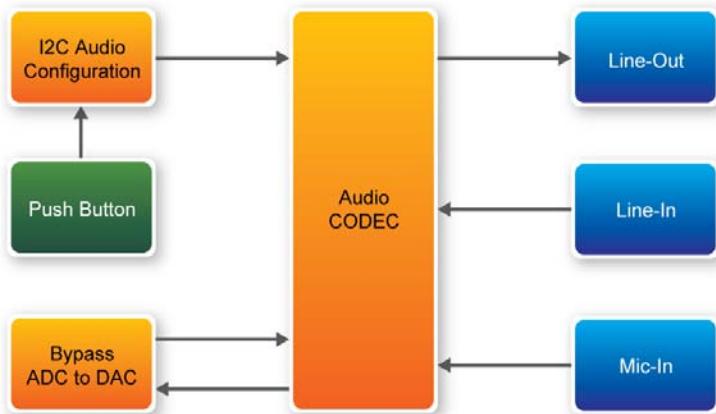


Figure 5-3 Block diagram of the Karaoke Machine demonstration

■ Demonstration Setup, File Locations, and Instructions

- Project directory: SOCKIT_i2sound
- Bit stream used: SOCKIT_i2sound.sof
- Connect a microphone to the microphone-in port (pink color) on the SOCKIT board
- Connect the audio output of a music-player, such as an MP3 player or computer, to the line-in port (blue color) on the SOCKIT board
- Connect a headset/speaker to the line-out port (green color) on the SOCKIT board
- Load the bit stream into the FPGA by execute the batch file ‘SOCKIT_i2sound’ under the SOCKIT_i2sound\demo_batch folder
- You should be able to hear a mixture of the microphone sound and the sound from the music player
- Press KEY0 to adjust the volume; it cycles between volume levels 0 to 9

Figure 5-4 illustrates the setup for this demonstration.

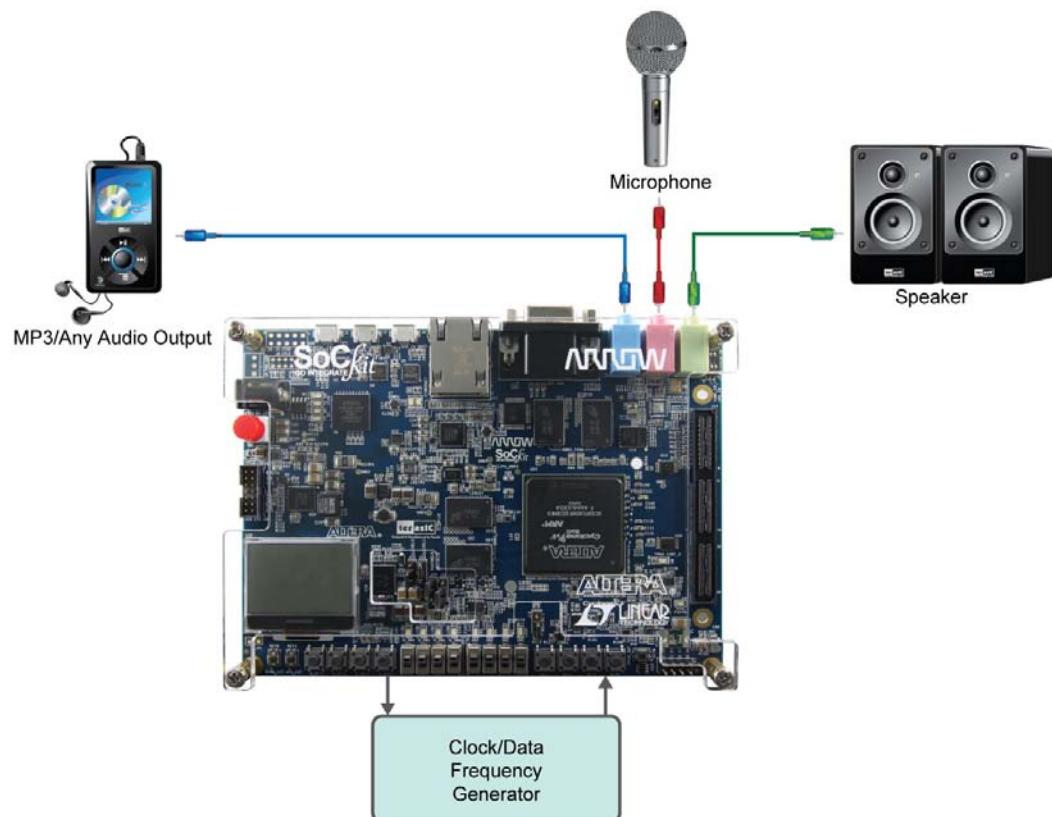


Figure 5-4 Setup for the Karaoke Machine

5.3 DDR3 SDRAM Test

This demonstration presents a memory test function on the bank of DDR3-SDRAM on the SoCKit board. The memory size of the DDR3 SDRAM bank is 1GB.

■ Function Block Diagram

Figure 5-5 shows the function block diagram of this demonstration. The controller uses 50 MHz as a reference clock, generates one 300 MHz clock as memory clock, and generates one half-rate system clock 150MHz for the controller itself.

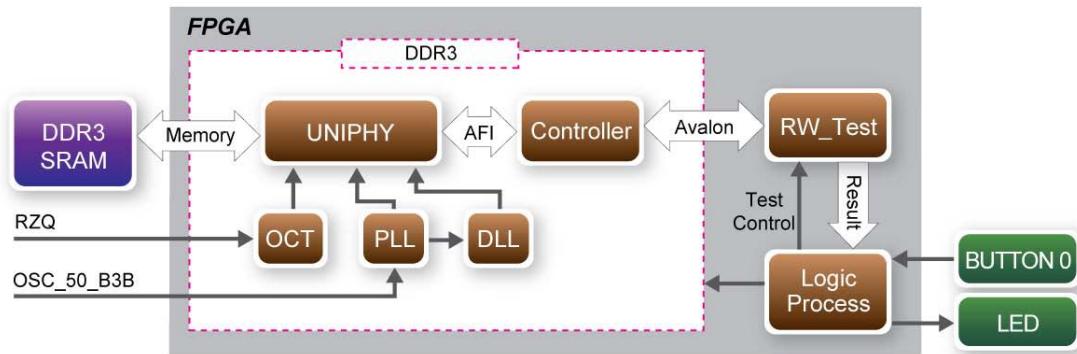


Figure 5-5 Block Diagram of the DDR3 SDRAM (1G) Demonstration

RW_test modules read and write the entire memory space of the DDR3 through the Avalon interface of the controller. In this project, the Avalon bus read/write test module will first write the entire memory and then compare the read back data with the regenerated data (the same sequence as the write data). KEY0 will trigger test control signals for the DDR3, and the LEDs will indicate the test results according to **Table 5-3**.

■ Altera DDR3 SDRAM Controller with UniPHY

To use the Altera DDR3 controller, users need to perform three major steps:

1. Create correct pin assignments for the DDR3.
2. Setup correct parameters in DDR3 controller dialog.
3. Perform “Analysis and Synthesis” by selecting from the Quartus II menu: Process→Start→Start Analysis & Synthesis.
4. Run the TCL files generated by DDR3 IP by selecting from the Quartus II menu: Tools→TCL Scripts...



■ Design Tools

- 64-Bit Quartus 13.0

■ Demonstration Source Code

- Project directory: SoCKit_DDR3_RTL_Test
- Bit stream used: SoCKit_DDR3_RTL_Test.sof

■ Demonstration Batch File

Demo Batch File Folder: *SoCKit_DDR3_RTL_Test \demo_batch*

The demo batch file includes following files:

- Batch File: SoCKit_DDR3_RTL_Test.bat
- FPGA Configure File: SoCKit_DDR3_RTL_Test.sof

■ Demonstration Setup

- Make sure Quartus II is installed on your PC.
- Connect the USB cable to the USB Blaster II connector (J2) on the SoCKit board and host PC.
- Power on the SoCKit board.
- Execute the demo batch file “SoCKit_DDR3_RTL_Test.bat” under the batch file folder, *SoCKit_DDR3_RTL_Test \demo_batch*.
- Press **KEY0** on the **SoCKit** board to start the verification process. When **KEY0** is pressed, the **LEDs (LED [2:0])** should turn on. At the instant of releasing **KEY0**, **LED1**, **LED2** should start blinking. After approximately 13 seconds, **LED1** should stop blinking and stay on to indicate that the DDR3 has passed the test, respectively. Table 4-2 lists the **LED** indicators.
- If **LED2** is not blinking, it means the 50MHz clock source is not working.
- If **LED1** do not start blinking after releasing KEY0, it indicates local_init_done or local_cal_success of the corresponding DDR3 failed.
- If **LED1** fail to remain on after 13 seconds, the corresponding DDR3 test has failed.
- Press **KEY0** again to regenerate the test control signals for a repeat test.

Table 5-3 LED Indicators

NAME	Description
LED0	Reset
LED1	If light, DDR3 test pass
LED2	Blinks

5.4 DDR3 SDRAM Test by Nios II

Many applications use a high performance RAM, such as a DDR3 SDRAM, to provide temporary storage. In this demonstration hardware and software designs are provided to illustrate how to perform DDR3 memory access in QSYS. We describe how the Altera's "DDR3 SDRAM Controller with UniPHY" IP is used to access a DDR3-SDRAM, and how the Nios II processor is used to read and write the SDRAM for hardware verification. The DDR3 SDRAM controller handles the complex aspects of using DDR3 SDRAM by initializing the memory devices, managing SDRAM banks, and keeping the devices refreshed at appropriate intervals.

■ System Block Diagram

Figure 5-6 shows the system block diagram of this demonstration. The system requires a 50 MHz clock provided from the board. The DDR3 controller is configured as a 1 GB DDR3-300 controller. The DDR3 IP generates one 300 MHz clock as SDRAM's data clock and one half-rate system clock 150 MHz for those host controllers, e.g. Nios II processor, accessing the SDRAM. In the QSYS, Nios II and the On-Chip Memory are designed running with the 100MHz clock, and the Nios II program is running in the on-chip memory.

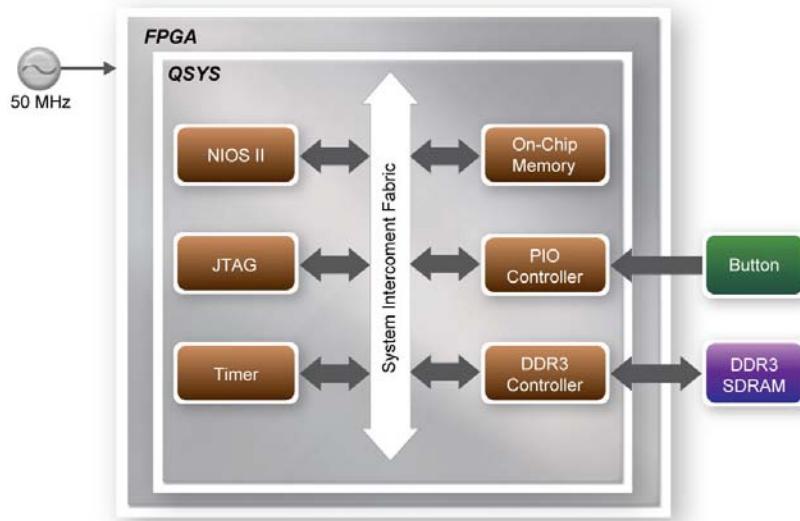


Figure 5-6 Block diagram of the DDR3 Basic Demonstration

The system flow is controlled by a Nios II program. First, the Nios II program writes test patterns into the whole 1 GB of SDRAM. Then, it calls Nios II system function, `alt_dache_flush_all`, to make sure all data has been written to SDRAM. Finally, it reads data from SDRAM for data verification. The program will show progress in JTAG-Terminal when writing/reading data to/from the SDRAM. When verification process is completed, the result is displayed in the JTAG-Terminal.



■ Altera DDR3 SDRAM Controller with UniPHY

To use Altera DDR3 controller, users need to perform the four major steps:

1. Create correct pin assignments for DDR3.
2. Setup correct parameters in DDR3 controller dialog.
3. Perform “Analysis and Synthesis” by clicking Quartus menu: Process→Start→Start Analysis & Synthesis.
4. Run the TCL files generated by DDR3 IP by clicking Quartus menu: Tools→TCL Scripts...

■ Design Tools

- Quartus II 13.0
- Nios II Eclipse 13.0

■ Demonstration Source Code

- Quartus Project directory: SoCKit_DDR3_Nios_Test
- Nios II Eclipse: *SoCKit_DDR3_Nios_Test\Software*

■ Nios II Project Compilation

Before you attempt to compile the reference design under Nios II Eclipse, make sure the project is cleaned first by clicking ‘Clean’ from the ‘Project’ menu of Nios II Eclipse.

■ Demonstration Batch File

Demo Batch File Folder:

SoCKit_DDR3_Nios_Test\demo_batch

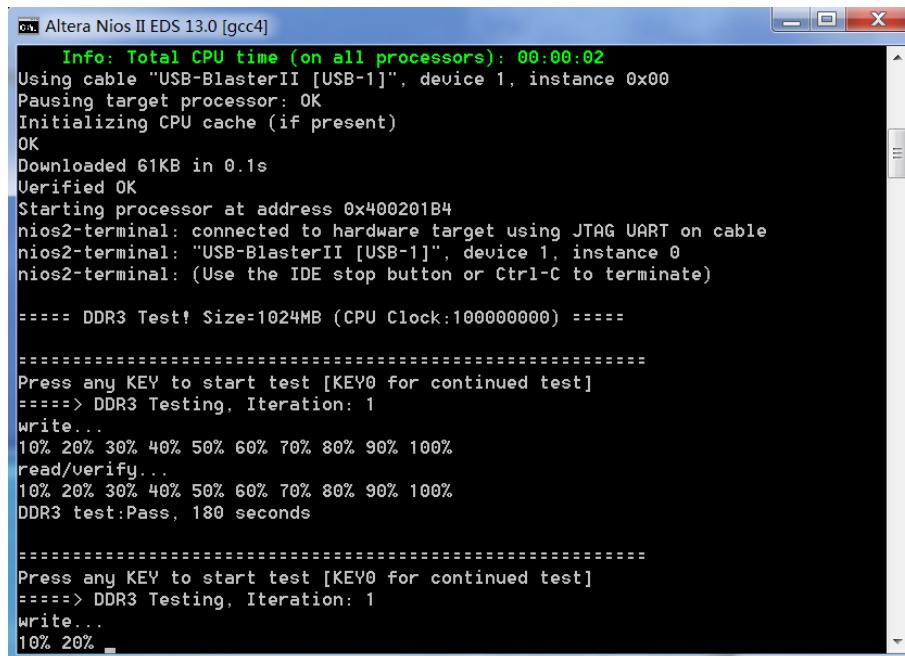
The demo batch file includes following files:

- Batch File for USB-Blaster (II) : SoCKit_DDR3_Nios_Test.bat,
SoCKit_DDR3_Nios_Test_bashrc
- FPGA Configure File : SoCKit_DDR3_Nios_Test.sof
- Nios II Program: SoCKit_DDR3_Nios_Test.elf

■ Demonstration Setup

- Make sure Quartus II and Nios II are installed on your PC.
- Power on the SoCKit board.
- Use USB cable to connect PC and the SoCKit board (J2) and install USB Blaster driver if necessary.

- Execute the demo batch file “*SoCKit-DDR3_Nios_Test.bat*” for USB-Blaster II under the batch file folder, *SoCKit-DDR3_Nios_Test\demo_batch*
- After Nios II program is downloaded and executed successfully, a prompt message will be displayed in nios2-terminal.
- Press **Button3~KEY0** of the SoCKit board to start SDRAM verify process. Press **KEY0** for continued test and press any to terminate the continued test.
- The program will display progressing and result information, as shown in **Figure 5-7**.



```

Info: Total CPU time (on all processors): 00:00:02
Using cable "USB-BlasterII [USB-1]", device 1, instance 0x00
Pausing target processor: OK
Initializing CPU cache (if present)
OK
Downloaded 61KB in 0.1s
Verified OK
Starting processor at address 0x400201B4
nios2-terminal: connected to hardware target using JTAG UART on cable
nios2-terminal: "USB-BlasterII [USB-1]", device 1, instance 0
nios2-terminal: (Use the IDE stop button or Ctrl-C to terminate)

===== DDR3 Test! Size=1024MB (CPU Clock:100000000) =====

=====
Press any KEY to start test [KEY0 for continued test]
=====> DDR3 Testing, Iteration: 1
write...
10% 20% 30% 40% 50% 60% 70% 80% 90% 100%
read/verify...
10% 20% 30% 40% 50% 60% 70% 80% 90% 100%
DDR3 test:Pass, 180 seconds

=====
Press any KEY to start test [KEY0 for continued test]
=====> DDR3 Testing, Iteration: 1
write...
10% 20% _
```

Figure 5-7 Display Progress and Result Information for the DDR3 Demonstration

5.5 IR Receiver Demonstration

In this demonstration, the key code information that the user has pressed on the remote controller(**Figure 5-8** , **Table 5-4**) will be displayed in nios2-terminal. **The remote controller can be purchased from Terasic website or user can use any remote control which the IR carrier frequency is 38K HZ.** The following descriptions of this demonstration are used Terasic remote controller. Users only need to point the remote controller to the IR receiver on SoCKit and press the key. After the signal being decoded and processed through FPGA, the related information will be included in hexadecimal format, which contains Custom Code, Key Code and Inversed Key Code. The Custom Code and Key Code are used to identify a remote controller and key on the remote controller, respectively. At final, the key code information will be displayed in nios2-terminal. **Figure 5-9** shows the block diagram of the design.



Figure 5-8 Terasic Remote controller

Table 5-4 Key code information for each Key on remote controller

Key	Key Code	Key	Key Code	Key	Key Code	Key	Key Code
A	0x0F	B	0x13	C	0x10	POWER	0x12
1	0x01	2	0x02	3	0x03	CHANNEL UP	0x1A
4	0x04	5	0x05	6	0x06	CHANNEL DOWN	0x1E
7	0x07	8	0x08	9	0x09	VOLUME UP	0x1B
■	0x11	0	0x00	◀	0x17	VOLUME DOWN	0x1F
▶	0x16	◀	0x14	▶	0x18	MUTE	0x0C
						RETURN	

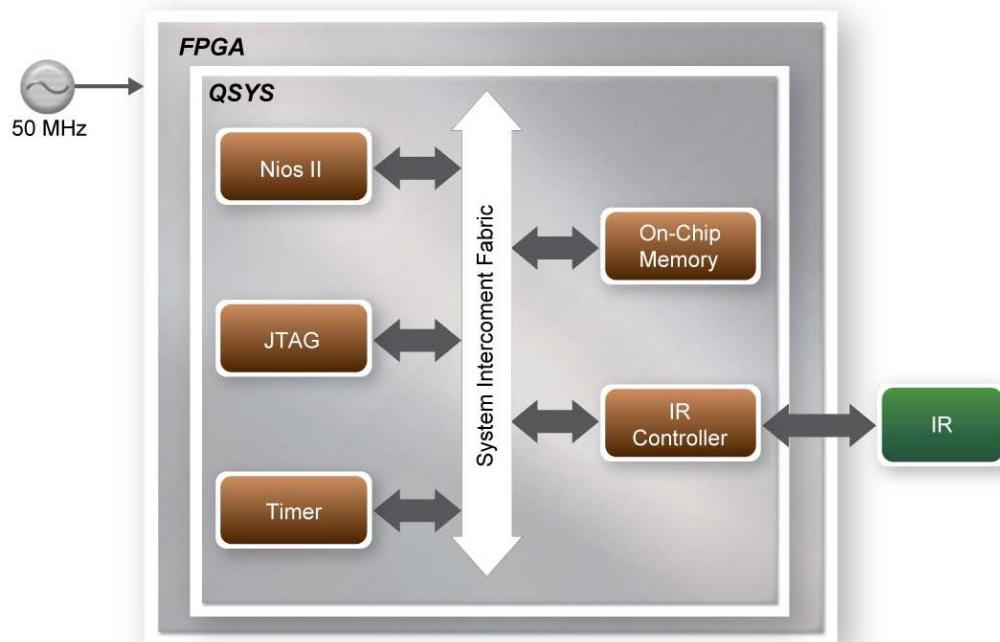


Figure 5-9 Block Diagram of the IR Receiver Demonstration

Next we will introduce how this information being decoded and then displayed in this demo.

When a key on the remote controller is pressed, the remote controller will emit a standard frame, shown in **Figure 5-10**. The beginning of the frame is the lead code represents the start bit, and then is the key-related information, and the last 1 bit end code represents the end of the frame.

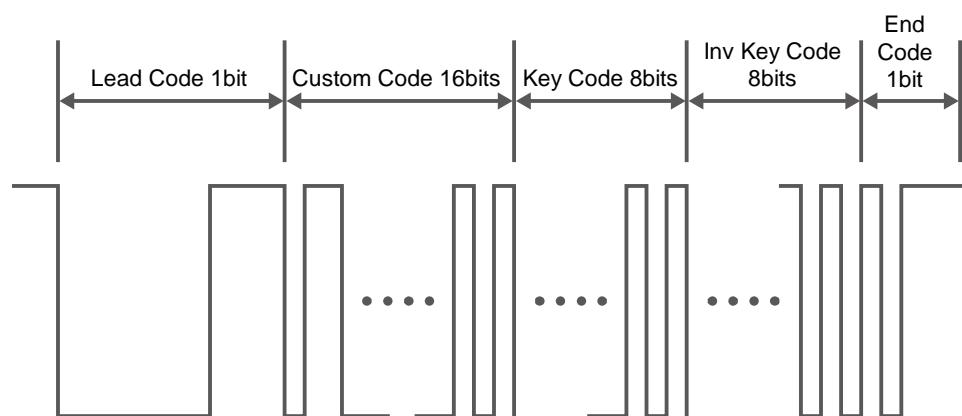


Figure 5-10 The transmitting frame of the IR remote controller

After the IR receiver on SoCKit receives this frame, it will directly transmit that to FPGA. In this demo, the IP of IR receiver controller is implemented in the FPGA. As [Figure 5-11](#) shows, it includes Code Detector, State Machine, and Shift Register. First, the IR receiver demodulates the signal inputs to Code Detector block .The Code Detector block will check the Lead Code and feedback the examination result to State Machine block.

The State Machine block will change the state from IDLE to GUIDANCE once the Lead code is detected. Once the Code Detector has detected the Custom Code status, the current state will change from GUIDANCE to DATAREAD state. At this state, the Code Detector will save the Custom Code and Key/Inv Key Code and output to Shift Register then displays it in nios2-terminal. [Figure 5-12](#) shows the state shift diagram of State Machine block. Note that the input clock should be 50MHz.

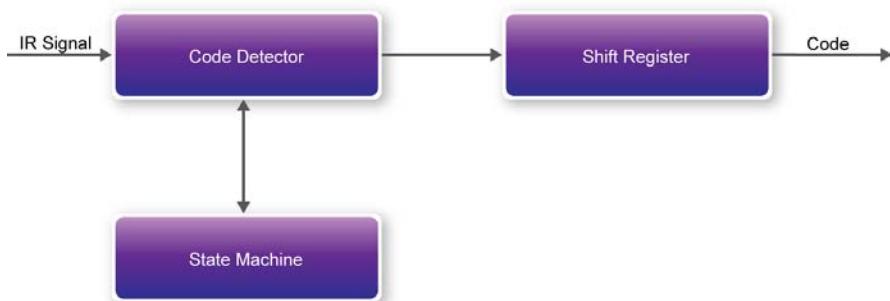


Figure 5-11 The IR Receiver controller

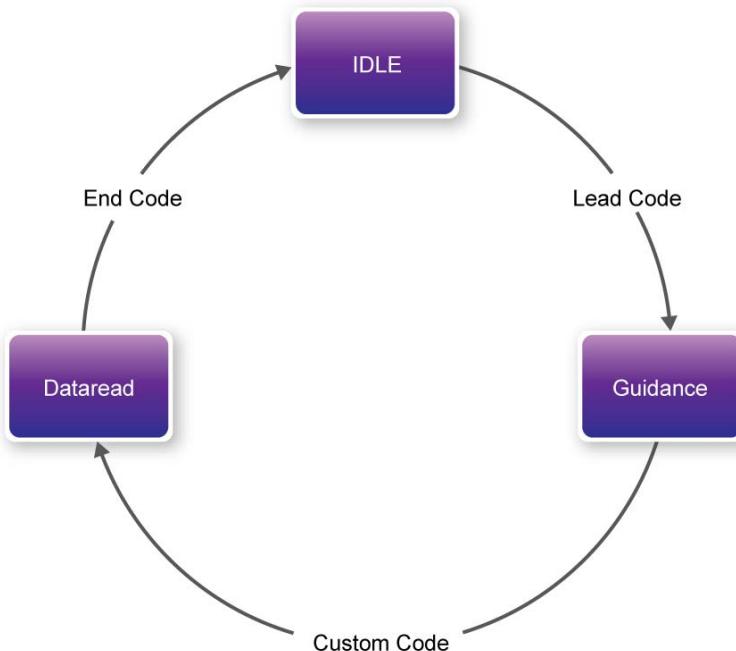


Figure 5-12 State shift diagram of State Machine

We can apply the IR receiver to many applications, such as integrating to the SD Card Demo, and you can also develop other related interesting applications with it.



Demonstration Source Code

- Project directory: SoCKit_IR
- Bit stream used: SoCKit_IR.sof
- Nios II Workspace: SoCKit_IR\Software

Demonstration Batch File

Demo Batch File Folder: SoCKit_IR\demo_batch

The demo batch file includes the following files:

- Batch File: SoCKit_IR.bat, SoCKit_IR_bashrc
- FPGA Configure File : SoCKit_IR.sof
- Nios II Program: SoCKit_IR.elf

Demonstration Setup, File Locations, and Instructions

- Make sure Quartus II and Nios II are installed on your PC.
- Power on the SoCKit board.
- Connect USB Blaster to the SoCKit board and install USB Blaster driver if necessary.
- Execute the demo batch file “SoCKit _IR.bat” under the batch file folder, SoCKit _IR \demo_batch.
- After Nios II program is downloaded and executed successfully, a prompt message will be displayed in nios2-terminal.
- Point the IR receiver with the remote-controller and press any button
- the information will be displayed in nios2-terminal, shown in **Figure 5-13**.

```
==== SoCKit IR Test ======Please press any key in remote controller!Key 0x0FPlease press any key in remote controller!Key 0x13Please press any key in remote controller!Key 0x10Please press any key in remote controller!Key 0x12Please press any key in remote controller!Key 0x01Please press any key in remote controller!Key 0x04Please press any key in remote controller!Key 0x05Please press any key in remote controller!Key 0x08Please press any key in remote controller!Key 0x09Please press any key in remote controller!Key 0x1BPlease press any key in remote controller!Key 0x17Please press any key in remote controller!
```

Figure 5-13 Running results of the IR demonstration

Figure 5-14 illustrates the setup for this demonstration.

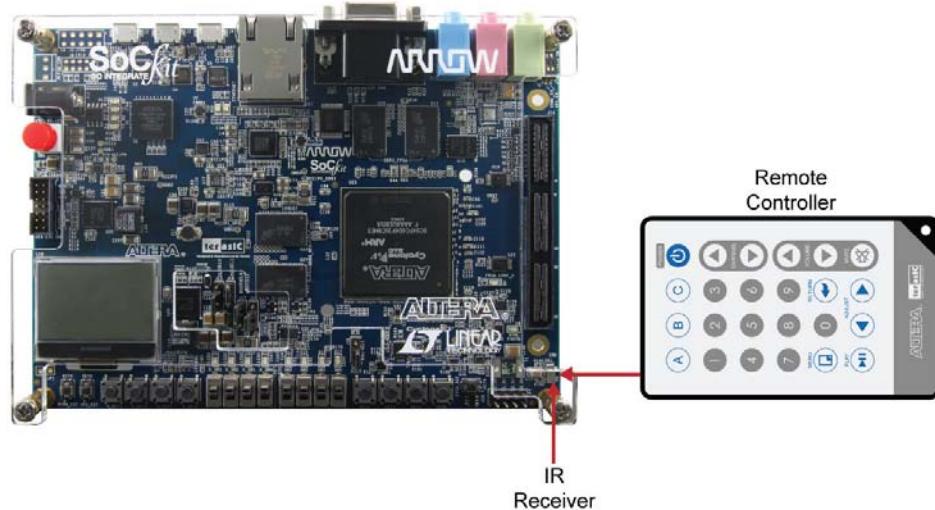


Figure 5-14 The Setup of the IR receiver demonstration

5.6 Temperature Demonstration

This demonstration illustrates how to use the ADT7301 device with the Nios II Processor to realize the function of board temperature detection. [Figure 5-15](#) shows the system block diagram of this demonstration. The ambient temperature information, which is collected by a built-in temperature sensor on the SoCKit board, can be converted into digital data by a 13-bit A/D converter. The generated digital data will be stored into the Temperature Value Register.

The sensor connects the FPGA device through a SPI interface. In this demonstration, a SPI master core is used by Nios II software to access the sensor's Temperature Value registers. Based on the register's values reading out in every five seconds, the program calculates the centigrade degree. The relative values are finally displayed onto the nios2-terminal window, in order to let the user monitor the board real-time temperature.

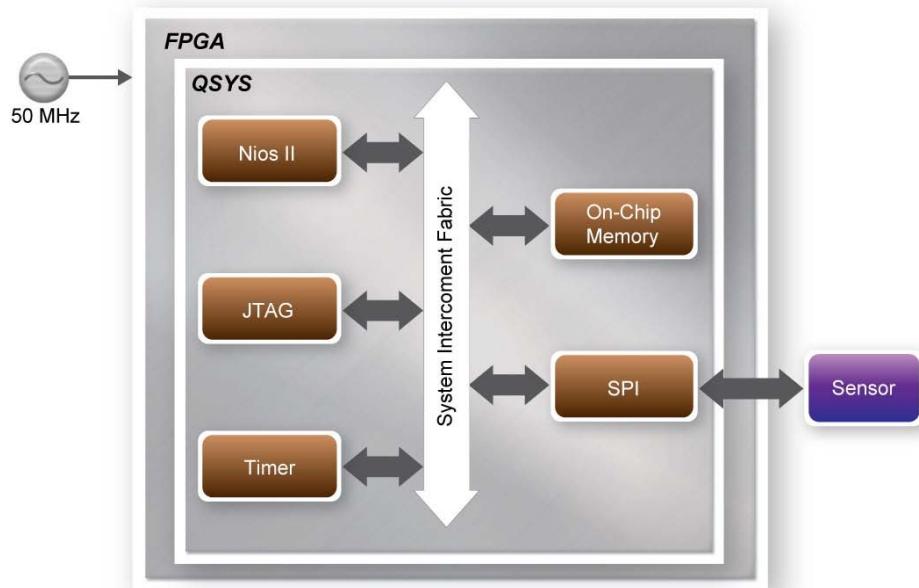


Figure 5-15 Block diagram of the Temperature Demonstration

Demonstration Source Code

- Project directory: SoCKit_TEMP
- Bit stream used: S0Ckit_TEMP.sof
- Nios II Workspace: SoCKit_TEMP\Software

Demonstration Batch File

Demo Batch File Folder: SoCKit_TEMP\demo_batch

The demo batch file includes the following files:

- Batch File: SoCKit_TEMP.bat, SoCKit_TEMP_bashrc
- FPGA Configure File : SoCKit_TEMP.sof
- Nios II Program: SoCKit _TEMP.elf

Demonstration Setup, File Locations, and Instructions

- Make sure Quartus II and Nios II are installed on your PC.
- Power on the SoCKit board.
- Connect USB Blaster to the SoCKit board and install USB Blaster driver II if necessary.



- Execute the demo batch file “SoCKit _TEMP.bat” under the batch file folder, SoCKit _TEMP \demo_batch.
- After Nios II program is downloaded and executed successfully, the related information will be displayed in nios2-terminal , shown in **Figure 5-16**.

```
===== SoCKit Temperature Sensor Test =====
00:00:00 : Board temperature: 33.06*C;
00:00:05 : Board temperature: 33.22*C;
00:00:10 : Board temperature: 33.25*C;
00:00:15 : Board temperature: 33.28*C;
00:00:20 : Board temperature: 33.31*C;
00:00:25 : Board temperature: 33.34*C;
00:00:30 : Board temperature: 33.38*C;
00:00:35 : Board temperature: 33.41*C;
00:00:40 : Board temperature: 33.44*C;
00:00:45 : Board temperature: 33.50*C;
00:00:50 : Board temperature: 33.56*C;
00:00:55 : Board temperature: 33.47*C;
00:01:00 : Board temperature: 33.44*C;
00:01:05 : Board temperature: 33.38*C;
00:01:10 : Board temperature: 33.56*C;
00:01:15 : Board temperature: 33.53*C;
00:01:20 : Board temperature: 33.62*C;
00:01:25 : Board temperature: 33.47*C;
00:01:30 : Board temperature: 33.50*C;
00:01:35 : Board temperature: 33.50*C;
00:01:40 : Board temperature: 33.47*C;
```

Figure 5-16 Running results of the Temperature demonstration



Chapter 6

Steps of Programming the Quad Serial Configuration Device

6.1 Revision History

This chapter describes how to program the quad serial configuration device with Serial Flash Loader (SFL) function via the JTAG interface. User can program quad serial configuration devices with a JTAG indirect configuration (.jic) file. To generate JIC programming files with the Quartus II software, users need to generate a user-specified SRAM object file (.sof), which is the input file first. Next, users need to convert the SOF to a JIC file. To convert a SOF to a JIC file in Quartus II software, follow these steps:

■ Before you Begin

Usually Quartus II includes a Serial Flash Loader (SFL) function .sof file for every FPGA device. Users just have to use Programmer to open an FPGA ‘s .jic file, and Programmer will automatically include a supported .sof file for the respective FPGA. Currently, however, there isn’t support for .sof files for the Cyclone V SOC FPGA in Quartus II v13.0. Users can remedy this situation by copying the sfl_enhanced_01_02d020dd.sof file from the Demonstration\SFL folder on the SoCKit System CD, to the programmer folder under your Quartus II installation (i.e. C:\altera\13.0\quartus\common\devinfo\programmer).

In addition, to use the Quad serial flash as an FPGA configuration device, the FPGA will need to be set in Asx4 mode. To do this, adjust the configuration mode switch (SW6) to let MSEL[4..0] to be set as “10010”.



■ Convert .SOF File to .JIC file

1. Choose **Convert Programming Files** on Quartus window (File menu).

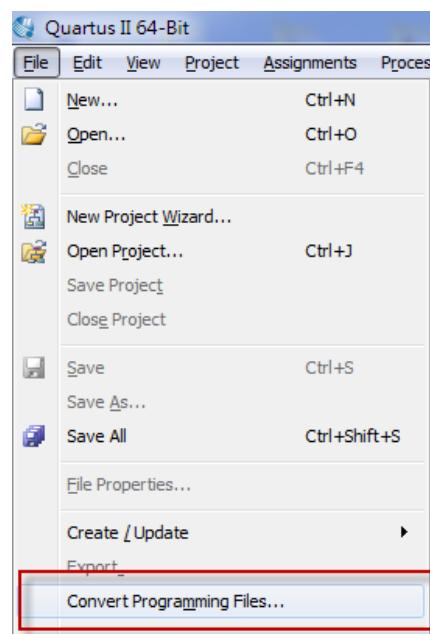


Figure 6-1. File menu of Quartus

2. In the **Convert Programming Files** dialog box, scroll to the **JTAG Indirect Configuration File (.jic)** from the **Programming file type** field.
3. In the **Configuration device** field, choose **EPCQ256**.
4. In the **Mode** field, choose **Active Serial X4**.
5. In the **File name** field, browse to the target directory and specify an output file name.
6. Highlight the SOF data in the Input files to convert section. See [Figure 6-2](#).

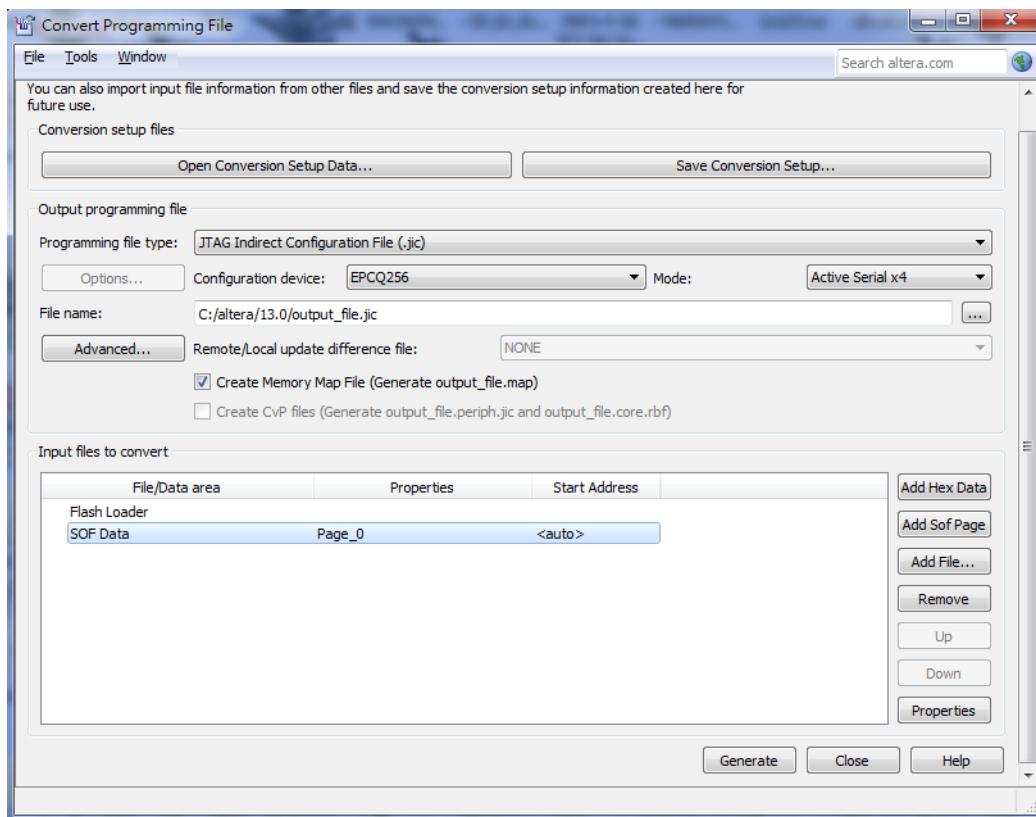


Figure 6-2. Convert Programming Files Dialog Box

7. Click **Add File**.
8. Select the SOF that you want to convert to a JIC file.
9. Click **Open**.
10. Highlight the Flash Loader and click **Add Device**. See [Figure 6-3](#).
11. Click **OK**. The Select Devices page displays.

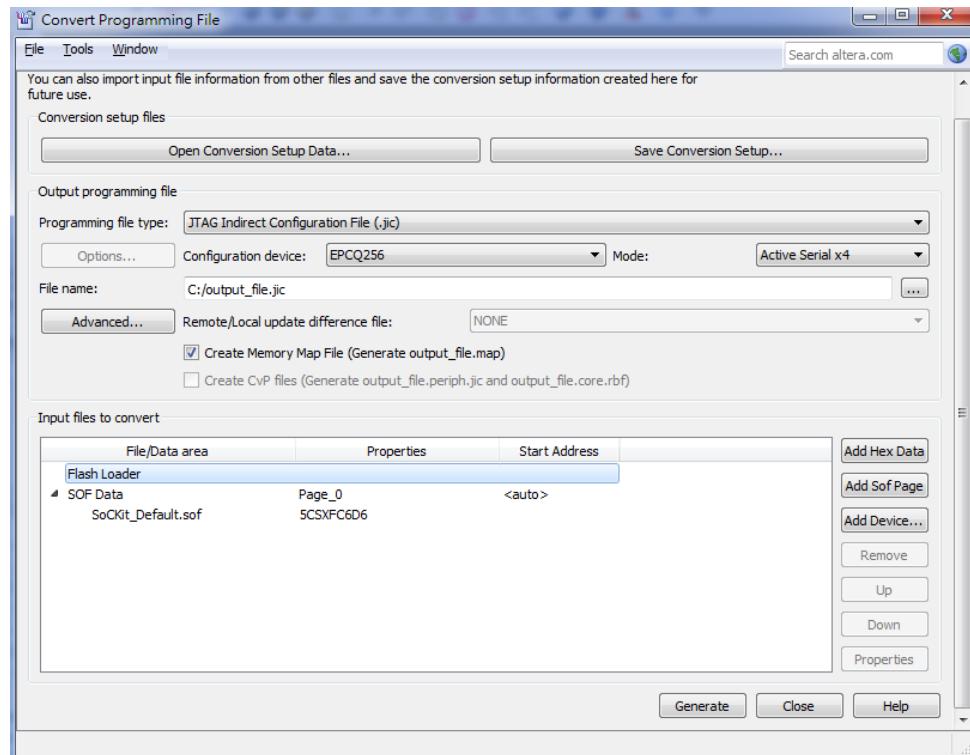


Figure 6-3. Highlight Flash Loader

12. Select the targeted FPGA that you are using to program the serial configuration device. See **Figure 6-4**.
13. Click OK. The **Convert Programming Files** page displays. See **Figure 6-5**.
14. Click **Generate**.

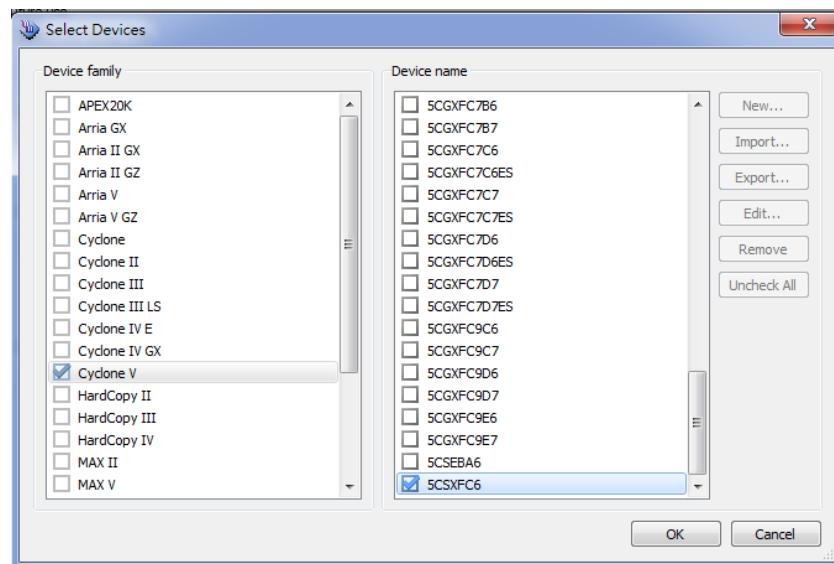




Figure 6-4. Select Devices Page

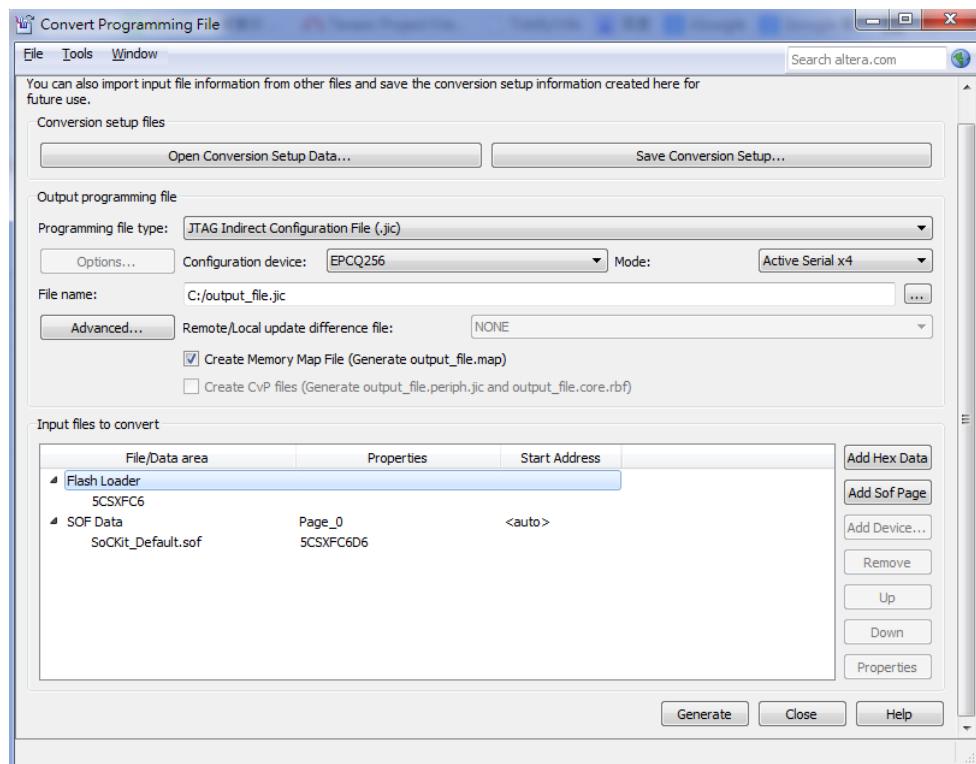


Figure 6-5. Convert Programming Files Page

■ Write JIC File into Quad Serial Configuration Device

To program the serial configuration device with the JIC file that you just created, add the file to the Quartus II Programmer window and follow the steps:

1. When the SOF-to-JIC file conversion is complete, add the JIC file to the Quartus II Programmer window:
 - i. Choose **Programmer** (Tools menu). The **Chain.cdf** window displays.
 - ii. Click **Add File**. From the **Select Programming File** page, browse to the JIC file.
 - iii. Click **Open**.
2. Program the serial configuration device by checking the corresponding **Program/Configure** box, a Factory default SFL image will be load (See [Figure 6-6](#)).

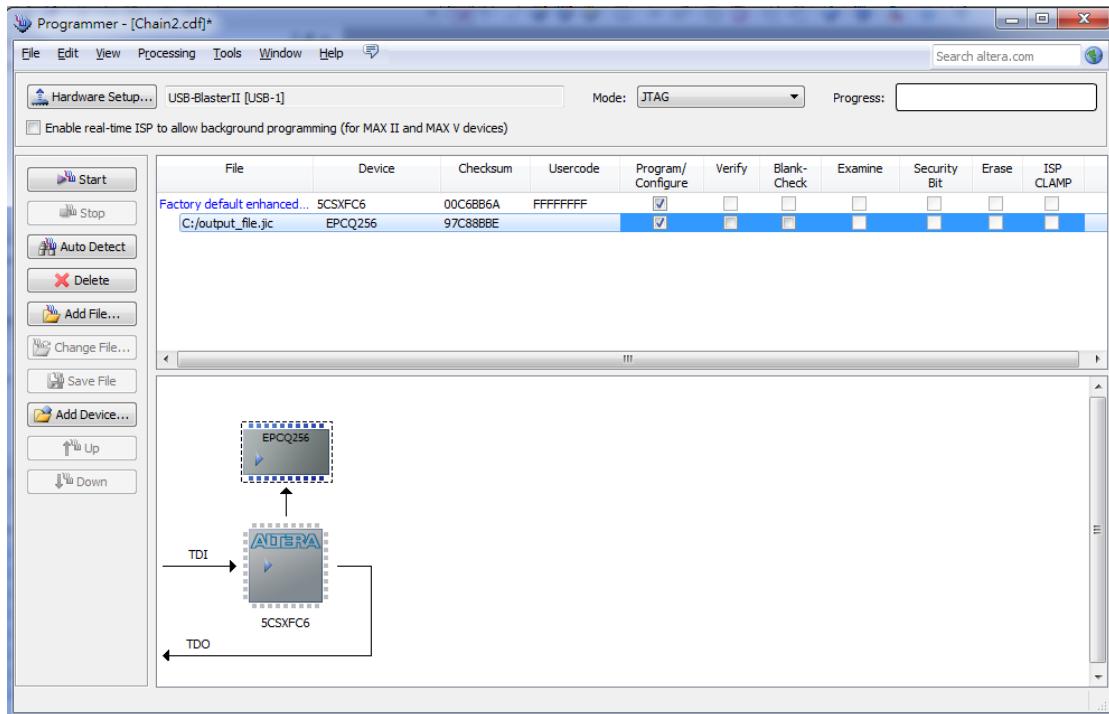


Figure 6-6. Quartus II programmer window with one JIC file

3. Click **Start** to program serial configuration device.

■ Erase the Quad Serial Configuration Device

To erase the existed file in the serial configuration device, follow the steps listed below:

1. Choose **Programmer** (Tools menu). The **Chain.cdf** window displays.
2. Click **Add File**. From the Select Programming File page, browse to a JIC file.
3. Click **Open**.
4. Erase the serial configuration device by checking the corresponding **Erase** box, a Factory default SFL image will be load (See **Figure 6-7**).

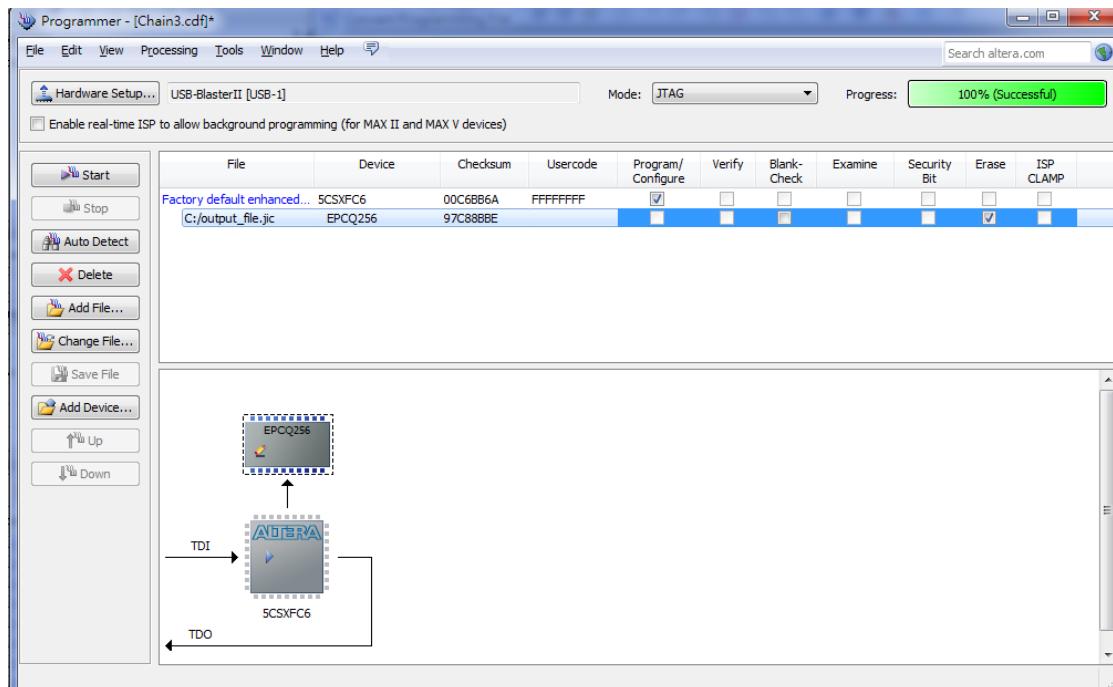


Figure 6-7 Erasing setting in Quartus II programmer window

5. Click **Start** to erase the serial configuration device.



Chapter 7

Appendix

7.1 Revision History

Version	Change Log
V0.1	Initial Version (Preliminary)
V0.2	Add CH5 and CH6
V0.3	Modify CH3

7.2 Copyright Statement

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